



COMMISSIONING OF THE Belle II **S**ILICON **V**ERTEX **D**ETECTOR



15TH VIENNA CONFERENCE ON INSTRUMENTATION

Home Programme Registration Contributions Travel Industrial Exhibition



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on behalf of the Belle II SVD Collaboration

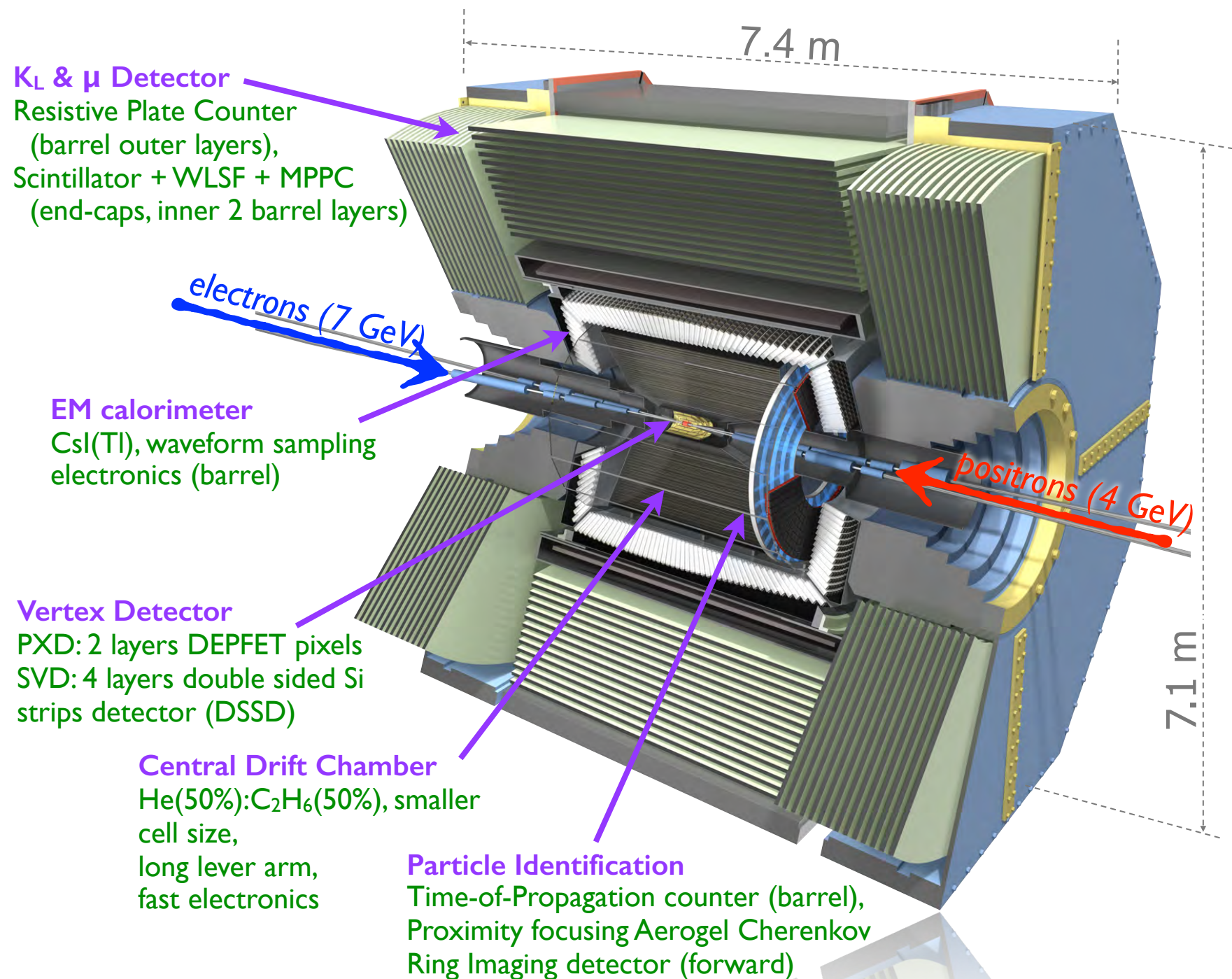


Outline

- The Belle II Silicon Vertex Detector*
- SVD Commissioning*
 - *highlights from small-scale SVD operations in global data taking*
 - *final detector commissioning*
- First Results from Global Cosmic Runs*

The Belle II Experiment

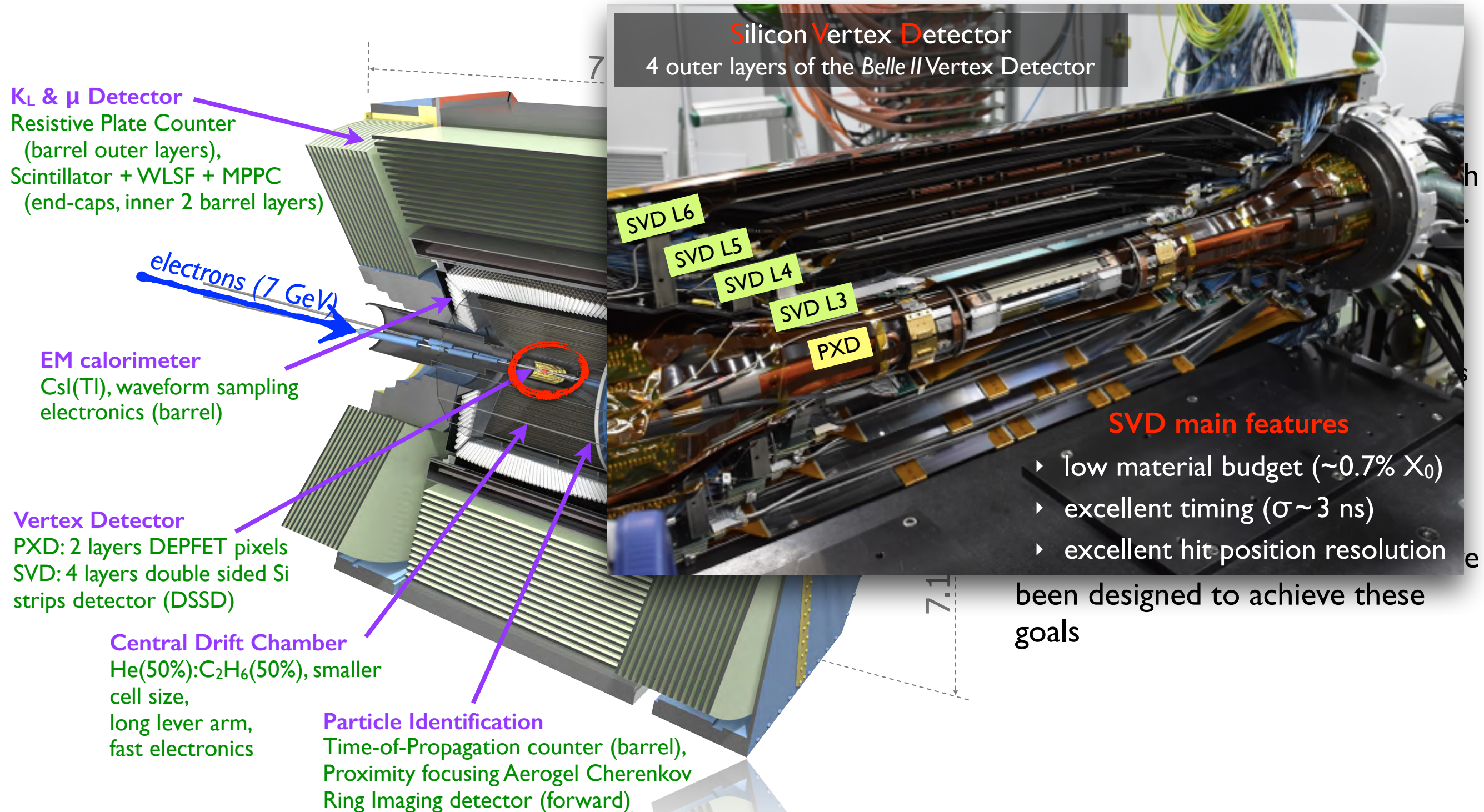
Belle II is a multi-purpose detector installed at the IP of the high-luminosity B-Factory SuperKEKB (design luminosity $8 \times 10^{35} \text{ cm}^{-2} \text{ s}^{-1}$), located at the KEK Laboratory - Tsukuba, Japan



- 10 years operation will allow to collect 50/ab (x50 the Belle dataset) providing the analysts with a statistical-error-breaking dataset.
- Physics measurements will benefit from the increase of statistics if:
 1. the *resolution* is comparable with Belle, or better
 2. the *systematic* error is reduced too
- the *Belle II* sub-detectors, in particular the vertex detector, have been designed to achieve these goals

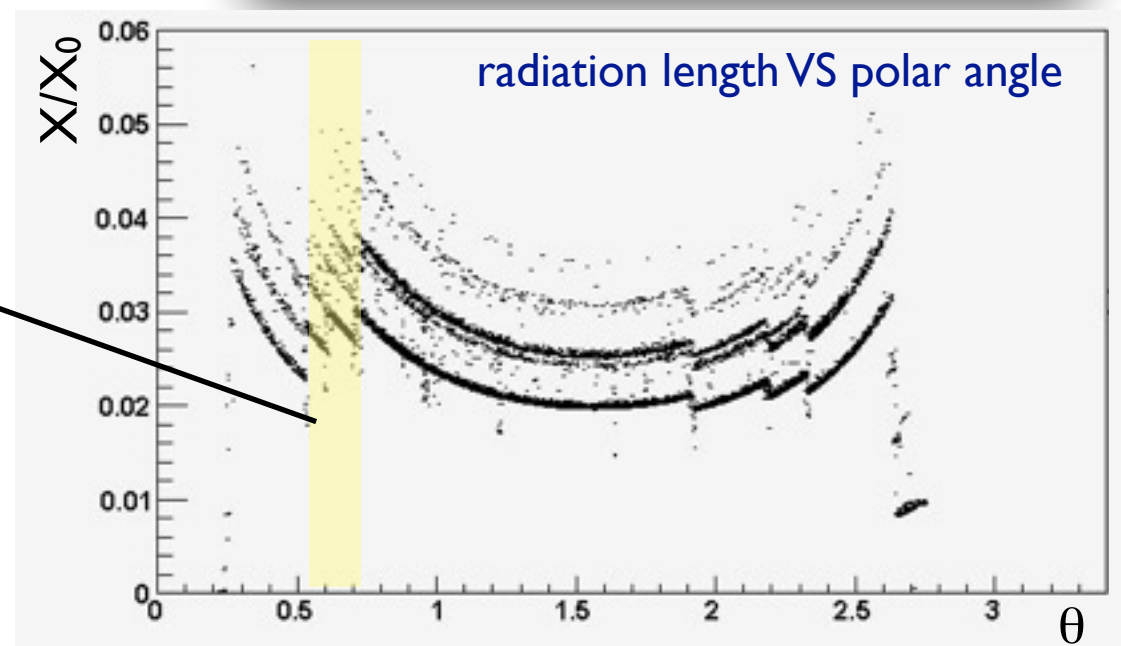
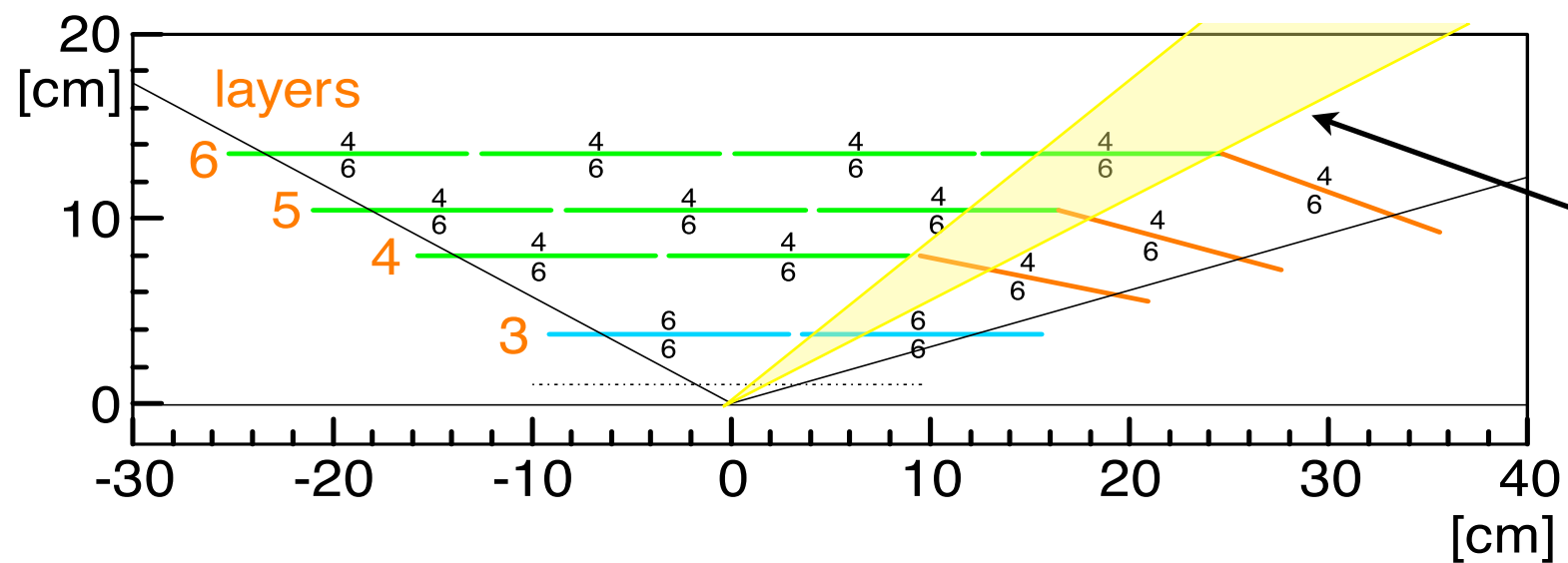
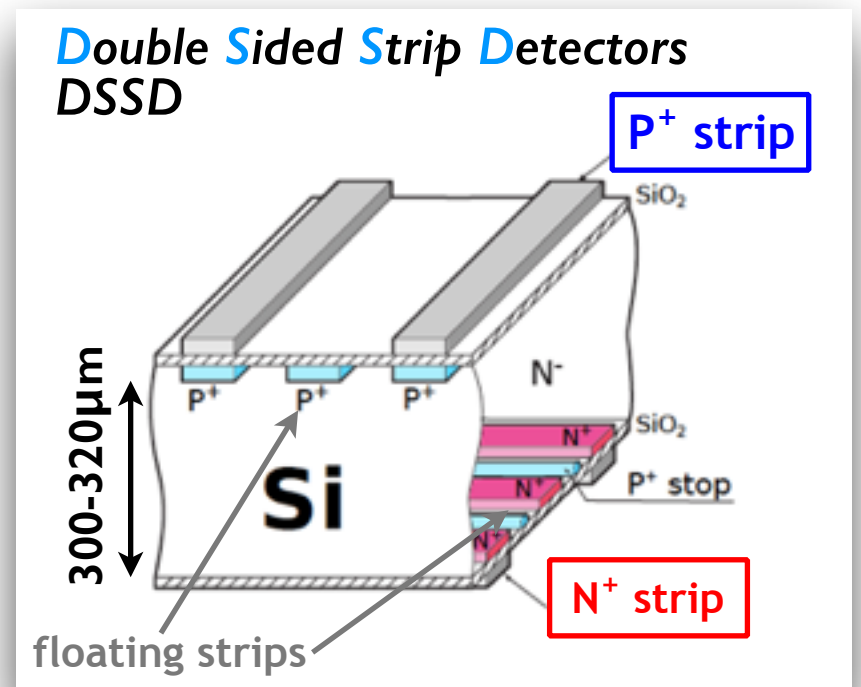
The Belle II Experiment

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The SVD Silicon Sensors

- ➔ 4 layers of DSSD on N-type silicon with AC coupled readout
- ➔ individual readout on each silicon sensor:
 - straightforward for sensors facing the non-tracking region
 - origami concept for all the other sensors (see [backup](#))
- ➔ lamp-shade geometry for layers 4,5, and 6
 - optimize track incident angle
 - reduced material budget in the forward region ($\theta < 0.7$)



➔ three sensor layouts, to reduce the design and production cost:

layer	type	readout strip(p/r- ϕ)	readout strip(n/z)	strip pitch (p/r- ϕ)	strip pitch (n/z)	sensors # (+ spares)	active area (mm ²)
4,5,6	large	768	512	75 μ m	240 μ m	120+18	122.90x57.72 = 7029.88
4,5,6 forward	trapezoidal	768	512	50-75 μ m	240 μ m	38+6	122.76x(57.59+38.42)/2 = 5893.09
3	small	768	768	50 μ m	160 μ m	14+4	122.90x38.55 = 4737.80

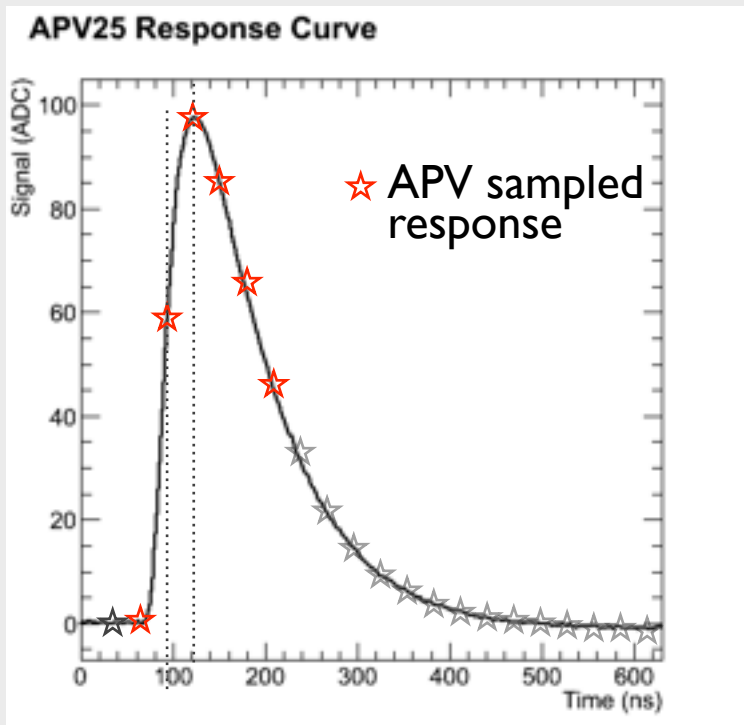
SVD Readout System

more details in Poster 67-B:

“Series Production Testing, Commissioning and Initial Operation of the Belle II Silicon Vertex Detector Readout System” by R.Thalmaier

The readout chip: APV25

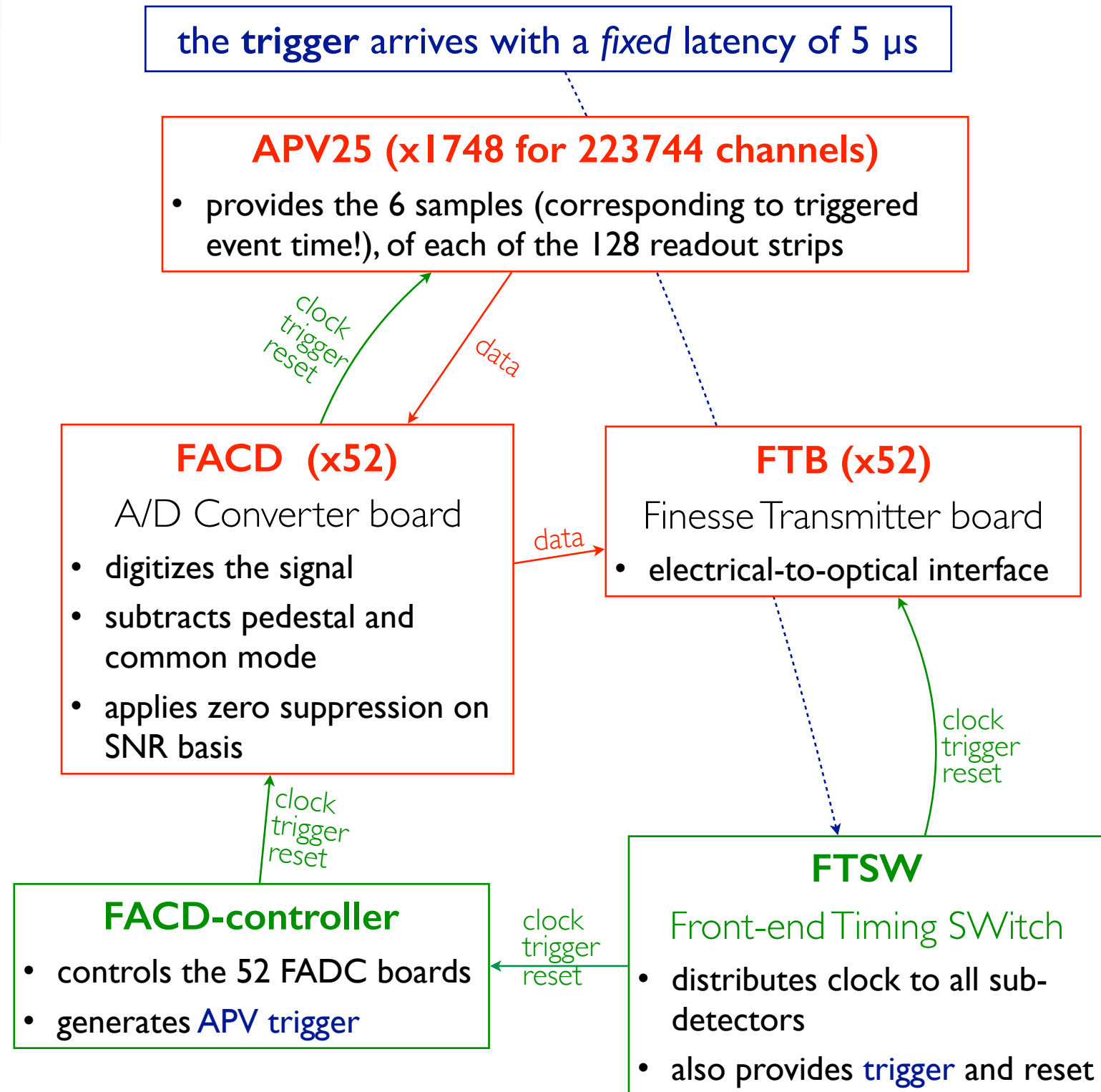
- ➔ originally developed for CMS
- ➔ shaping time of 50 ns
 - low occupancy
- ➔ thinned to 100 μm
 - low material budget
- ➔ operated in multi-peak mode @ ~ 32 MHz, equipped with a 192 deep analog pipeline
- ➔ APV clock synchronised with bunch crossing frequency of $\sim 8 \times 32$ MHz



the trigger arrives with a *fixed* latency of 5 μs

APV25 (x1748 for 223744 channels)

- provides the 6 samples (corresponding to triggered event time!), of each of the 128 readout strips



SVD Timeline

more details on background in Poster 39-B:
 "Measurements of Beam Background at SuperKEKB"
 by L. Santelj

Phase2
SVD

Phase2 experiment

- data from e^+e^- collisions @ $Y(4S)$ energy
- with an incomplete *Belle II* detector (no final-version VXD)
- with a **reduced-scale vertex detector** and
- dedicated beam-background detectors

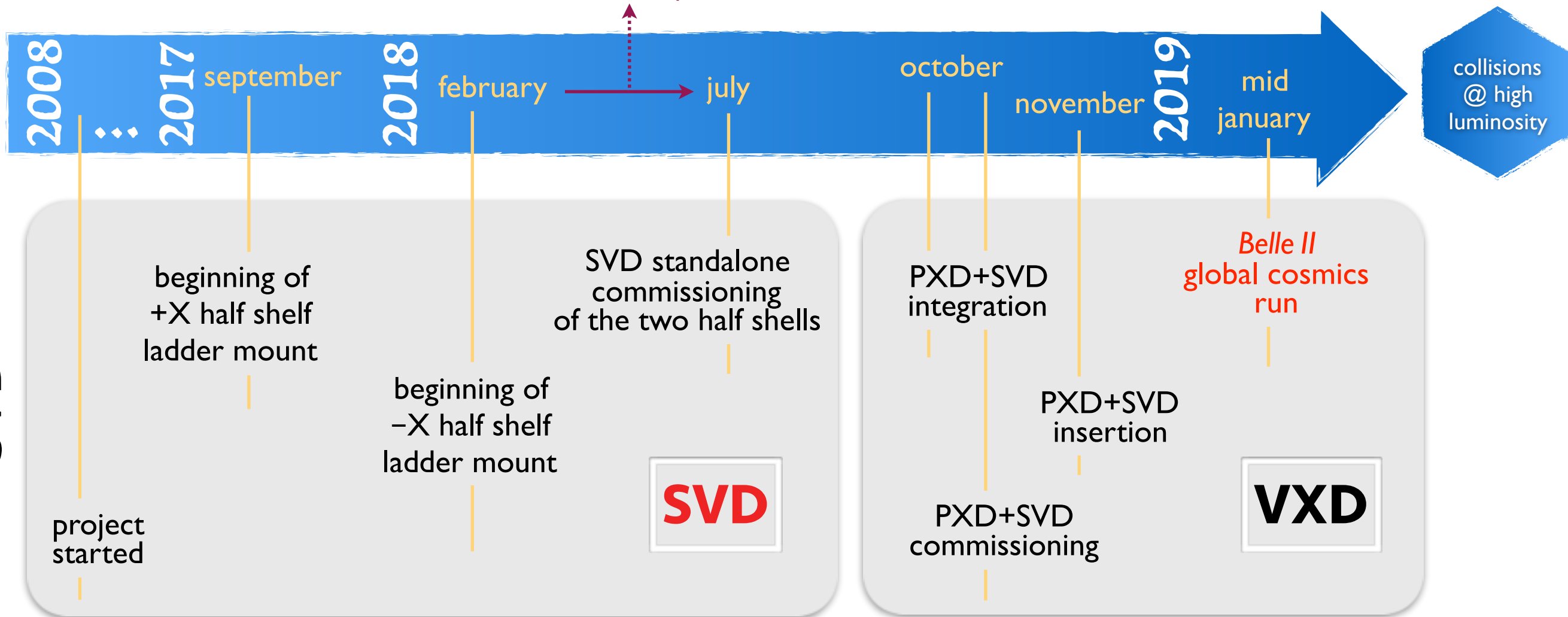
Phase2 main goals

- understand machine background
- understand detector performance
- detector subsystems commissioning
- detector calibration, ...

focus of this talk is on detector performance

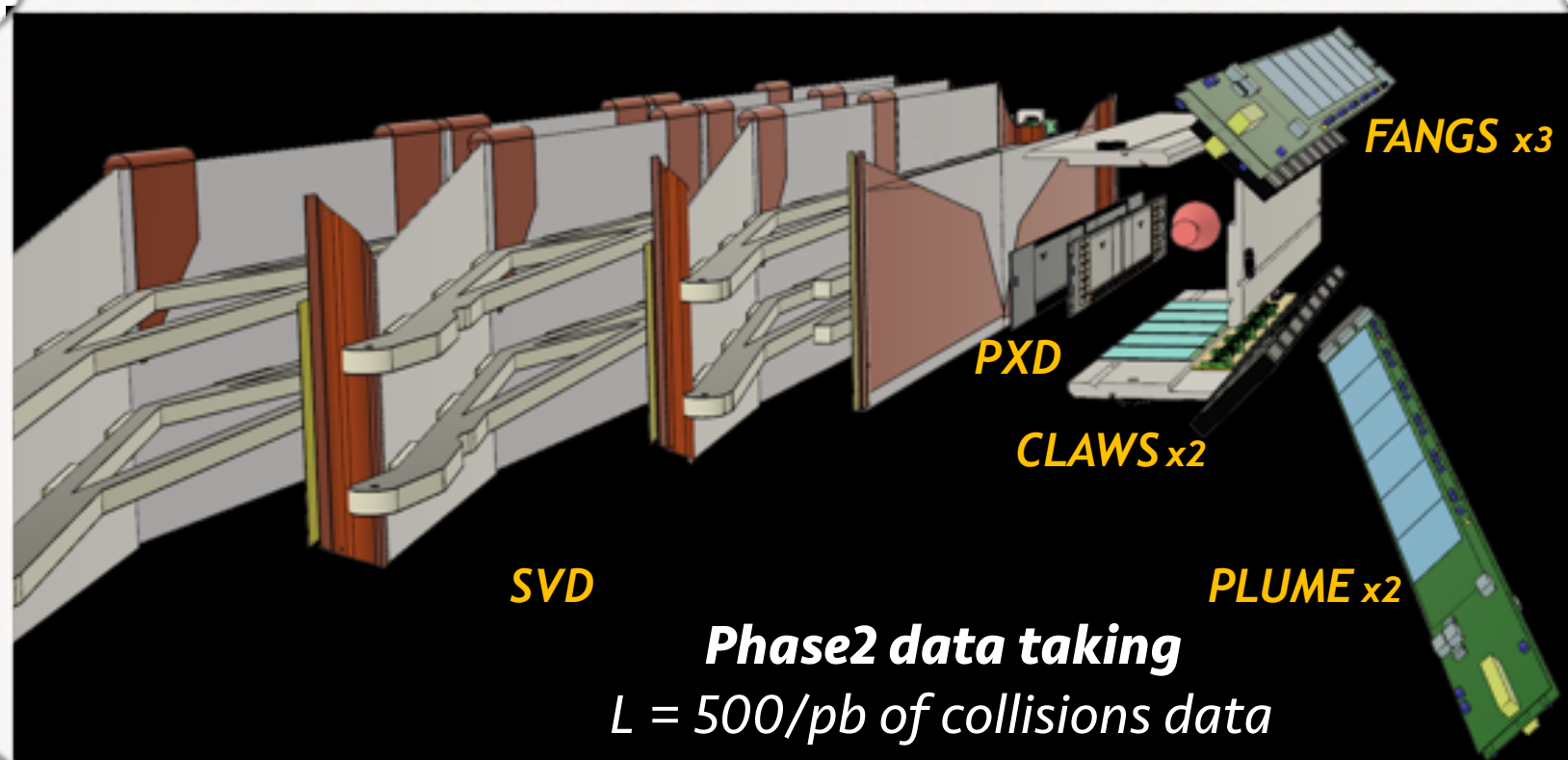
Phase2 collisions dataset

$L = 500/\text{pb}$



SVD

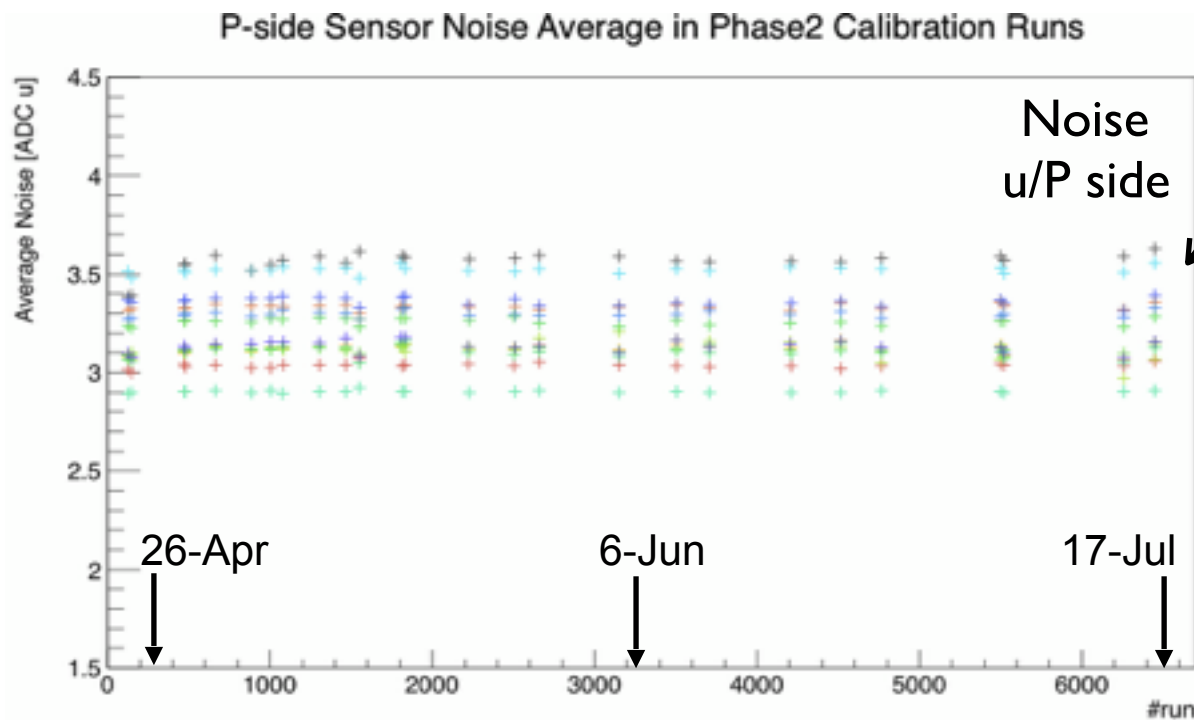
- ☑ *The Belle II Silicon Vertex Detector*
- ☑ **SVD Commissioning**
 - *highlights from small-scale SVD operations in global data taking*



SVD in Phase2 Global Data Taking

☑ Phase2 SVD detector was operated since the beginning of Phase2, taking data in all runs

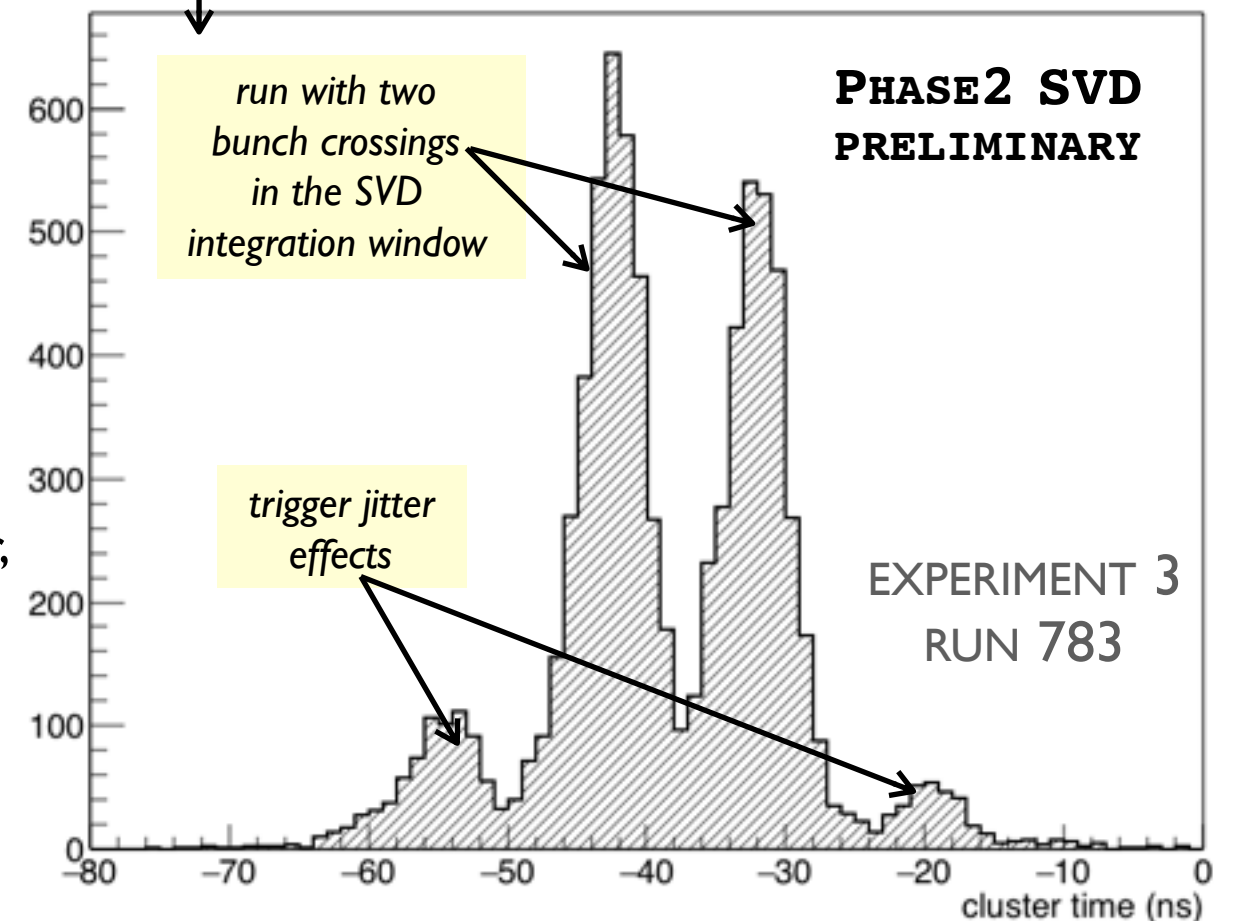
- important experience gained in operating a *small-scale SVD* (14 vs 172 sensors) for what concerns **detector calibrations stability & subsystems commissioning**



very stable calibration constants (gain, noise) of all sensors, over Phase2 running

SVD sees bunch crossings 16 ns apart

Cluster Related to Tracks, Hit Time, Large Rectangular sensors V/N



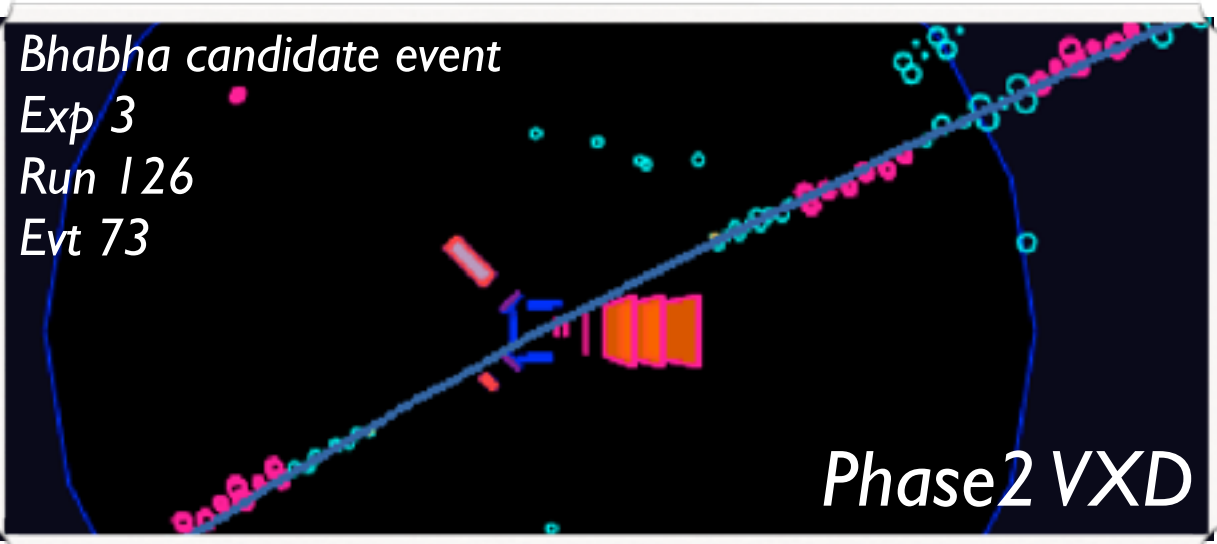
note: SVD hit time is not calibrated in this plot

- test of sensor response to MIPs from IP

- sensor efficiencies above 97%* for all-except-one sensor, good considering class B sensors have been used

- confirmed *impact of SVD reconstruction on tracking*, even if with only one ladder per layer

SVD Impact on Tracking in Phase2



➔ Phase2 SVD covers a small azimuthal, nonetheless measurements of tracks with SVD hits confirmed that:

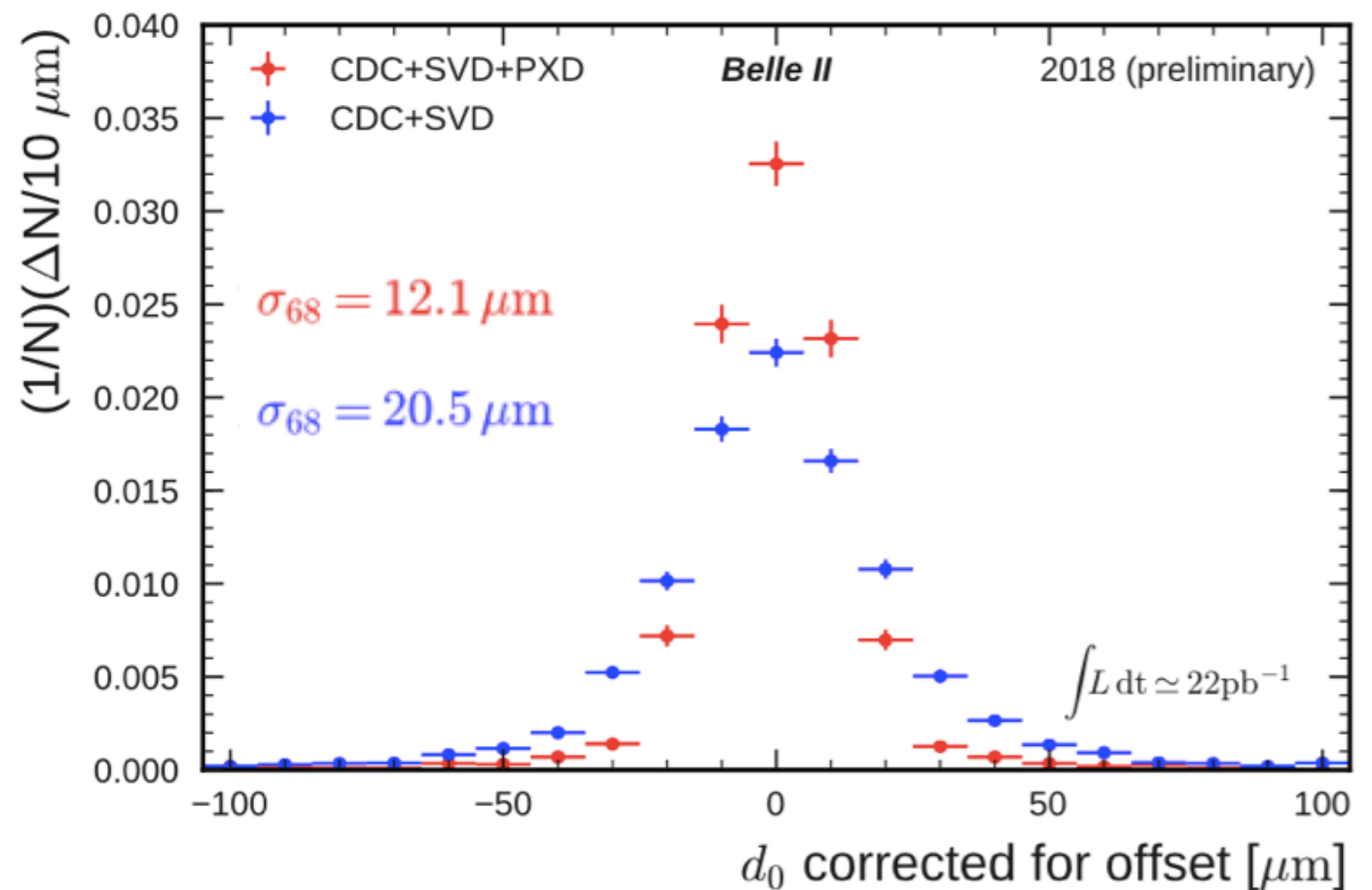
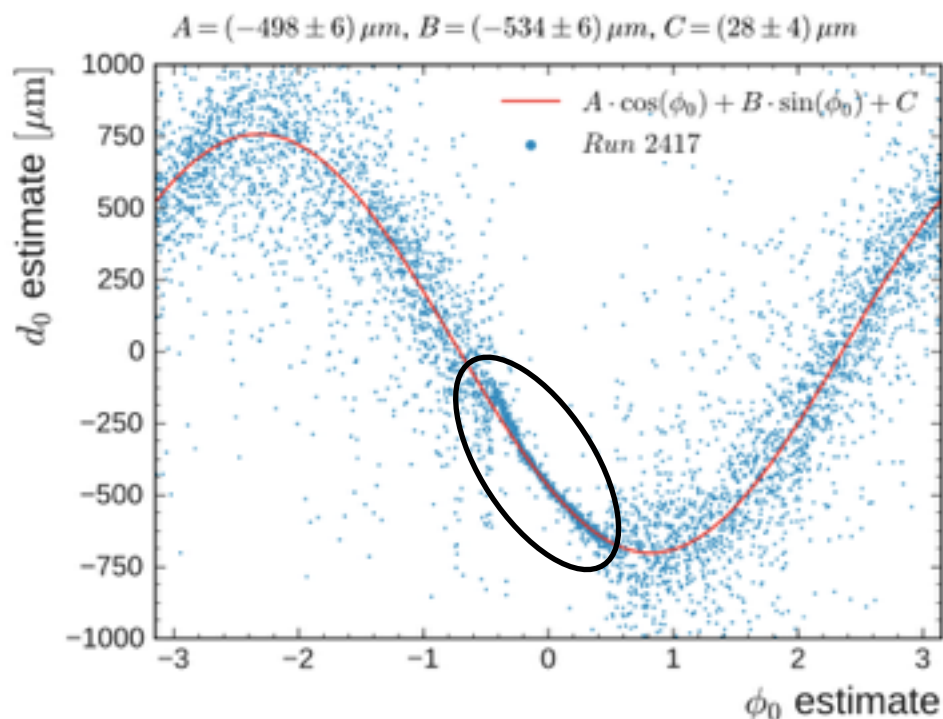
- svd-only tracking is working
- outward extrapolation from SVD is working

➔ track d_0 resolution $\sim 20 \mu\text{m}$ (w/o PXD hits)

- innermost SVD layer at 3.9 cm from IP

➔ IP not in the nominal position, correlation between track parameters d_0 and ϕ_0

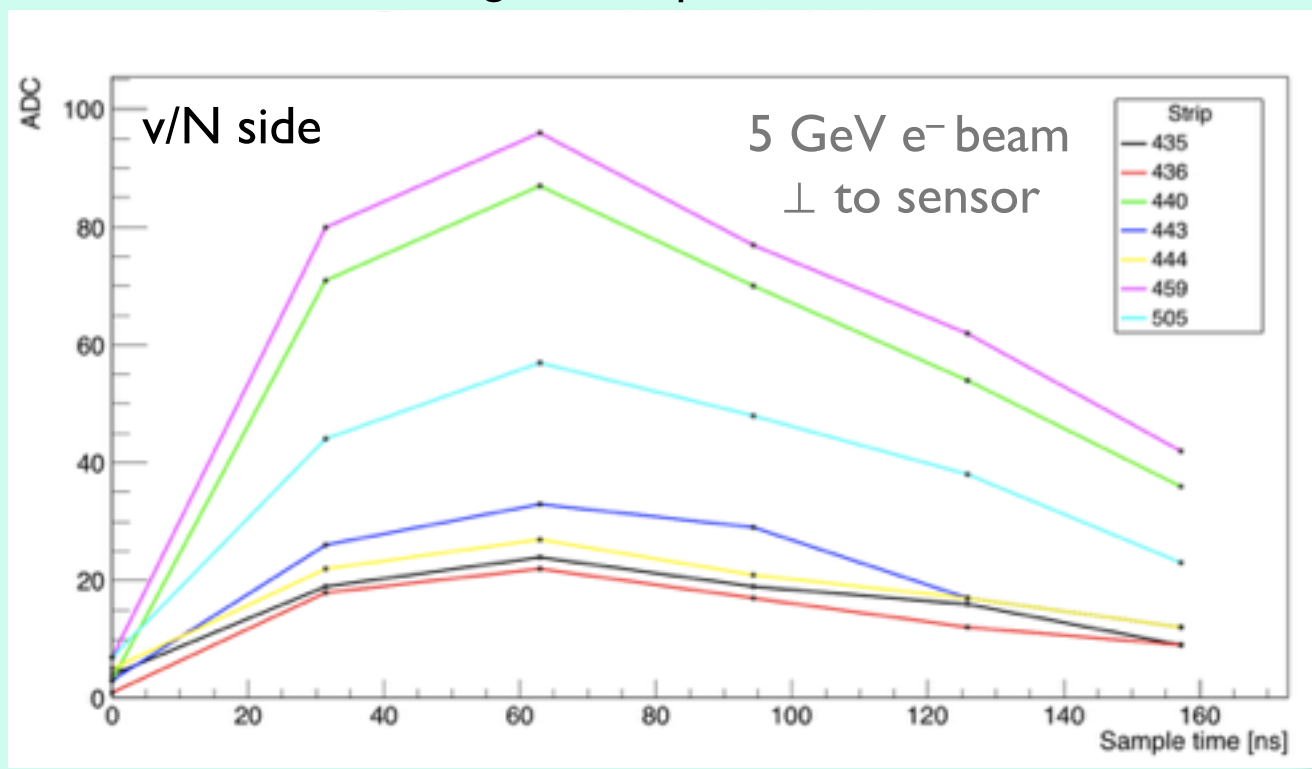
- evident improvement of the resolution in the VXD direction



The SVD Hit Time Determination

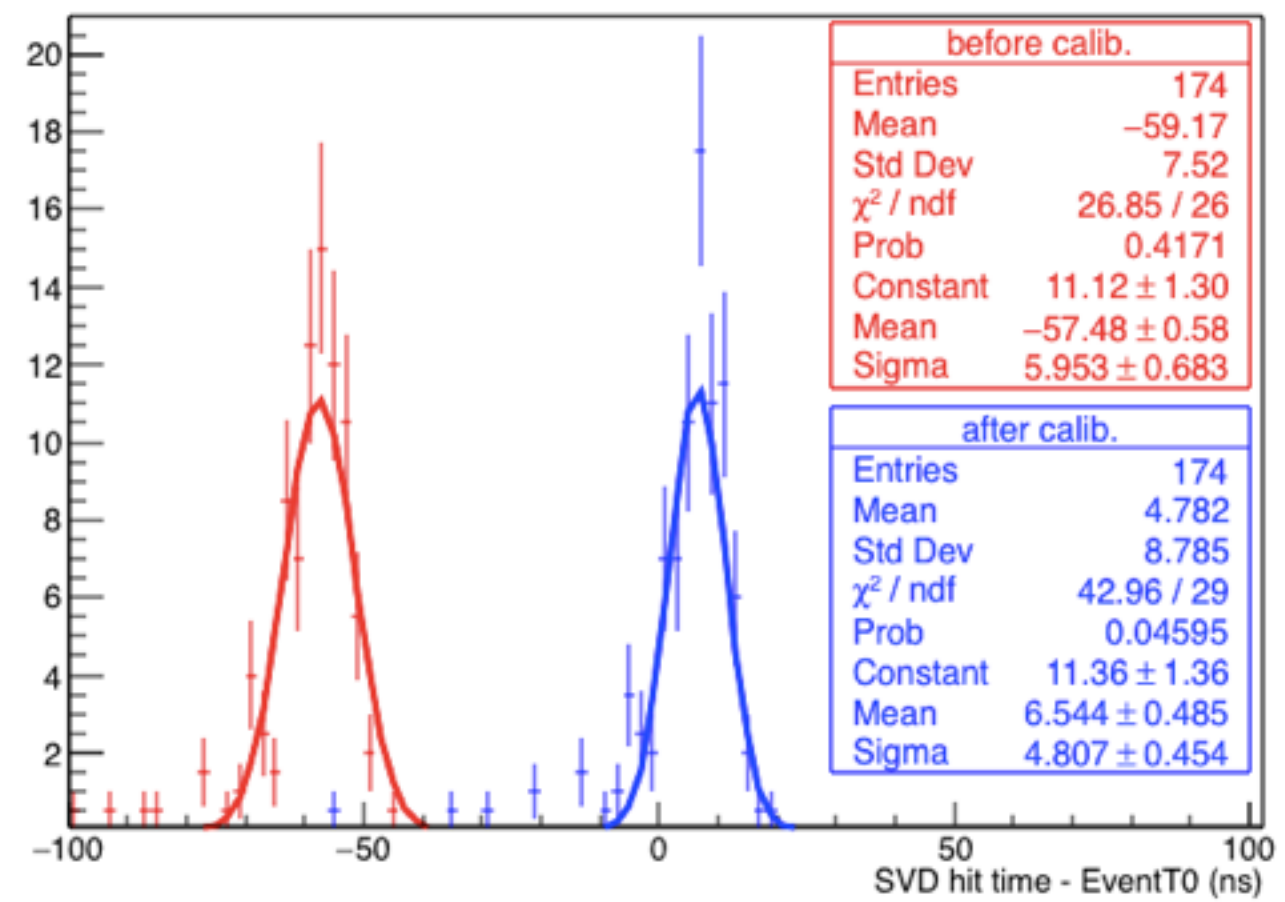
- ➔ Precise determination of the SVD hit time is crucial for the tracking performances at nominal luminosity
 - most of the beam background hits come from particles generated at past bunch-crossings with respect to the triggered event
 - rejection of off-time hits significantly reduces the beam background occupancy

main ingredient: 6 samples provided by the APV25, after digitisation, pedestal and CM subtraction



- ➔ SVD time *before* the calibration:
 - $(t_{\text{raw}} - t_0)$ resolution ~ 6 ns
- ➔ SVD time *after* calibration (with event time t_0)
 - $(t_{\text{SVD}} - t_0)$ resolution ~ 5 ns

SVD Hit Time – EventT0 provided by the drift chamber



Strong indication of excellent time resolution of hits from tracks coming from the interaction point

EventT0 estimation error included in the $(t_{\text{SVD}} - \text{EventT0})$ width

Outline

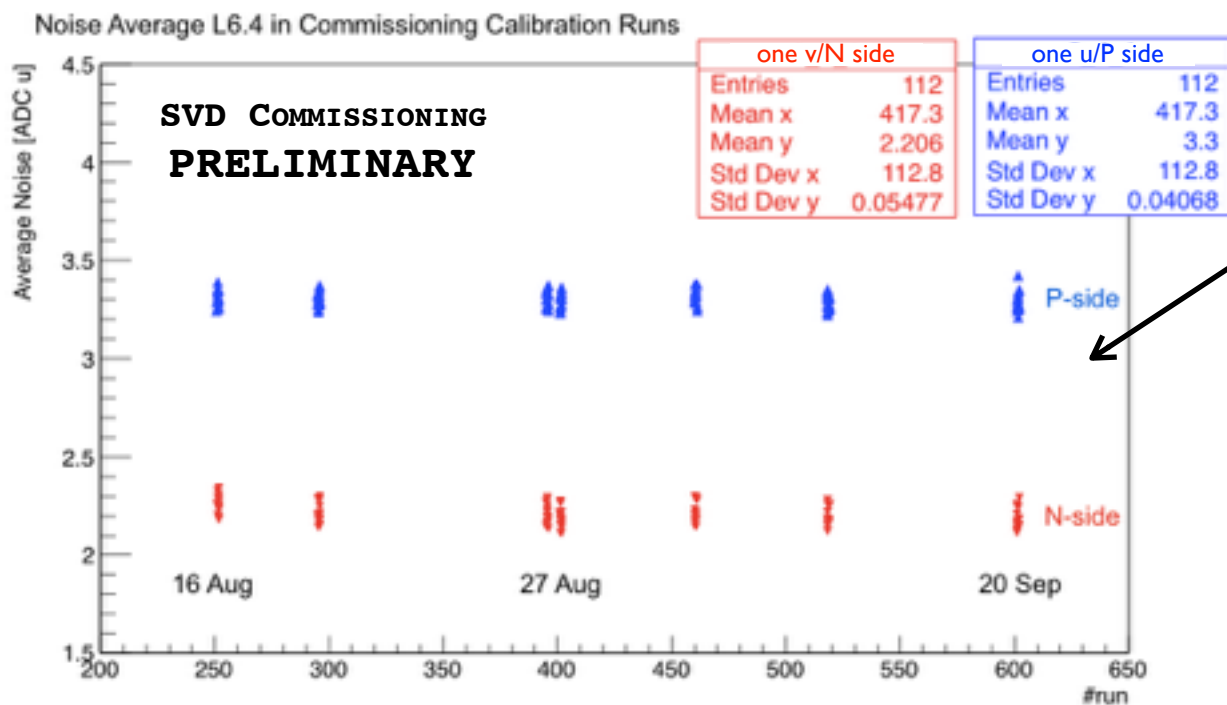
- The Belle II Silicon Vertex Detector*
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 - **final detector commissioning**
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SVD Standalone Commissioning

The Final SVD detector has been successfully commissioned summer last year

➔ Only minor problems observed, related to cooling, very few sensors showed some issues, not serious

1. **detector calibrations stability** confirmed as observed with small-scale SVD in Phase2



very stable calibration constants (gain, noise) of all sensors, over 2 months of running

SVD commissioning setup

triggers provided by scintillators coincidence:

- ~jitterless
- asynchronous with respect to SVD readout clock

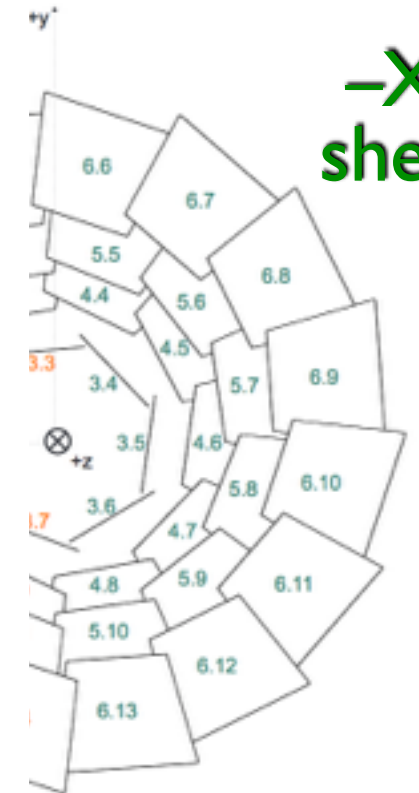
TOP scintillator #1

TOP scintillator #2



no B-field

-X shell



BOTTOM scintillator #2

BOTTOM scintillator #1

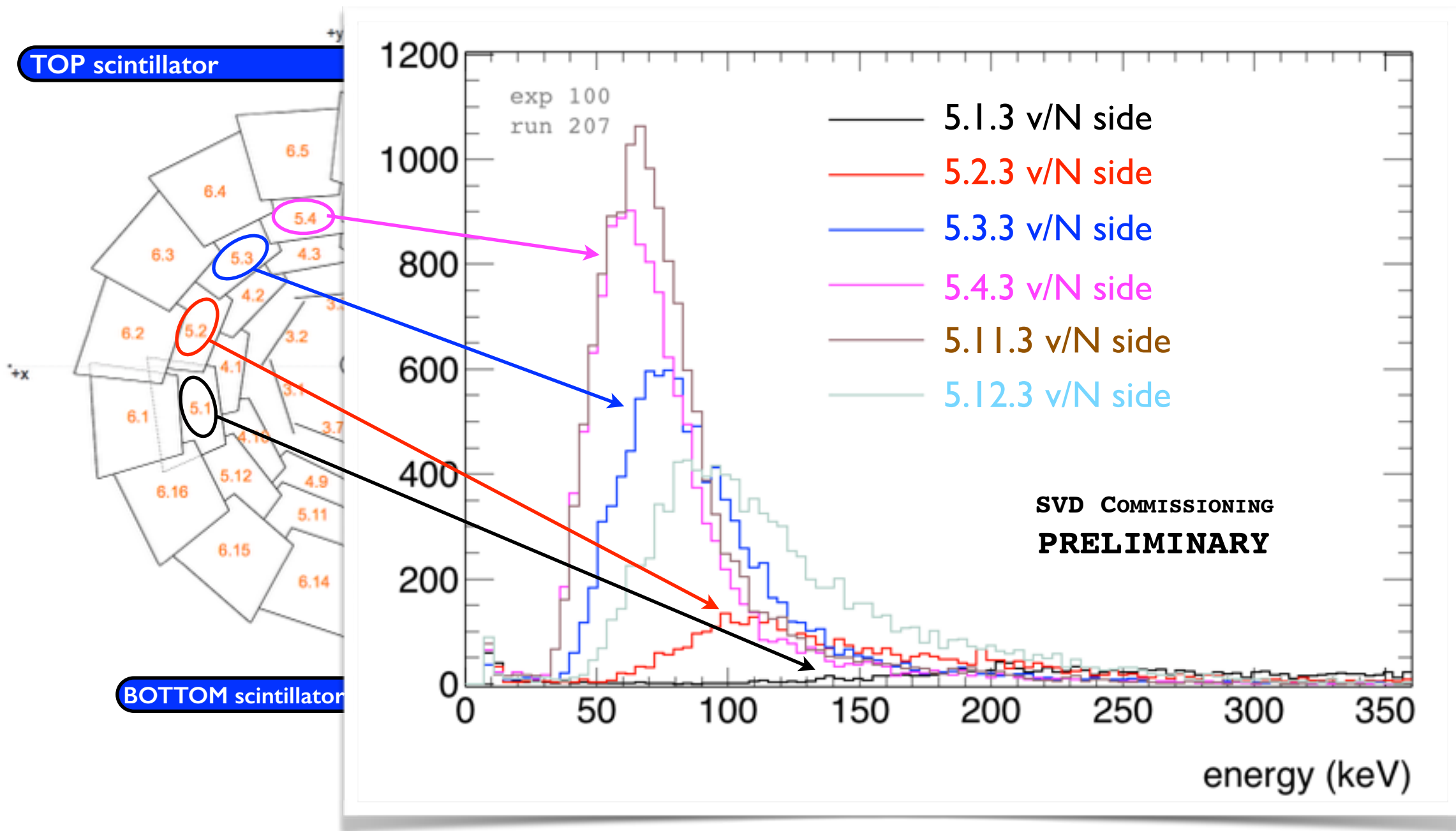
note: one point represents a sensor of layer 6 ladder 4

2. useful dataset to test the final detector sensors response to MIPs (not from IP!)

- reconstruction versus track incident angle
- **sensor efficiencies above 99%** for most of the sensors, details later

Cluster Energy VS Azimuthal Angle

➔ Cosmic rays cross vertical layers with a larger incident angle with respect to horizontal layers

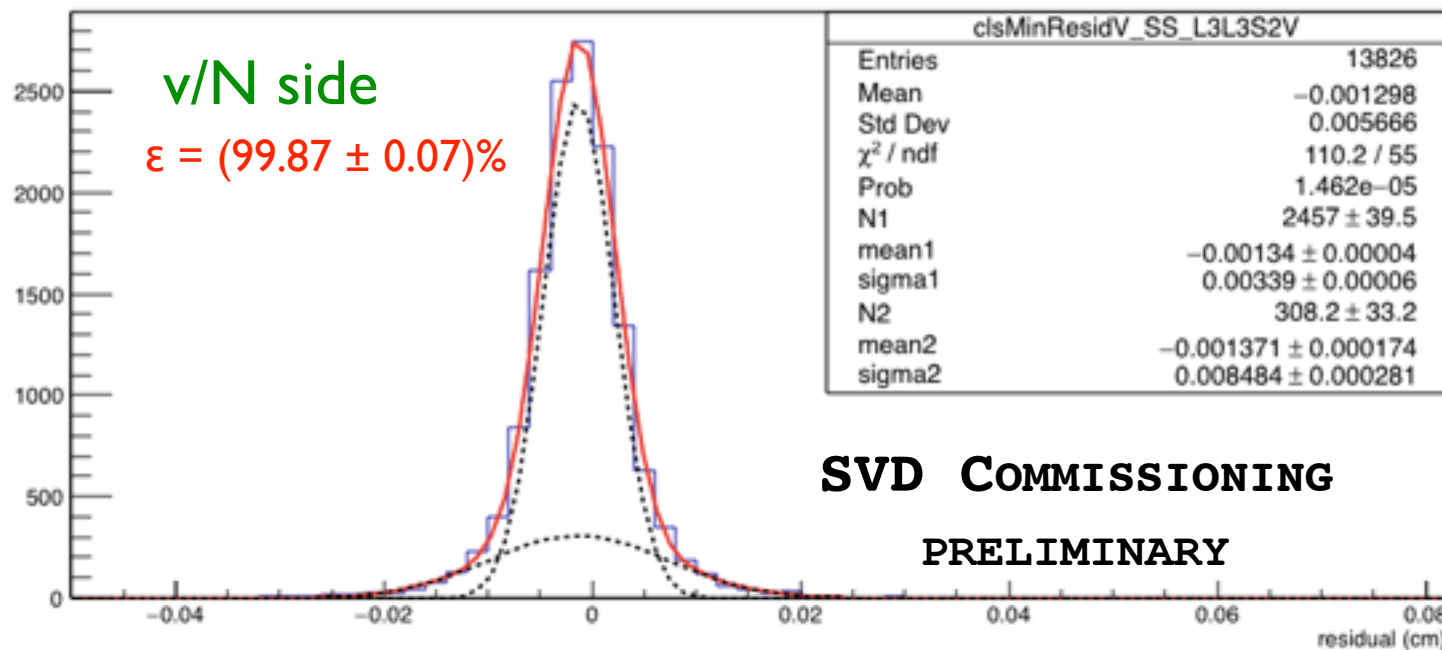


Concentrate on *horizontal* sensor to study the \perp track incident angle use-case

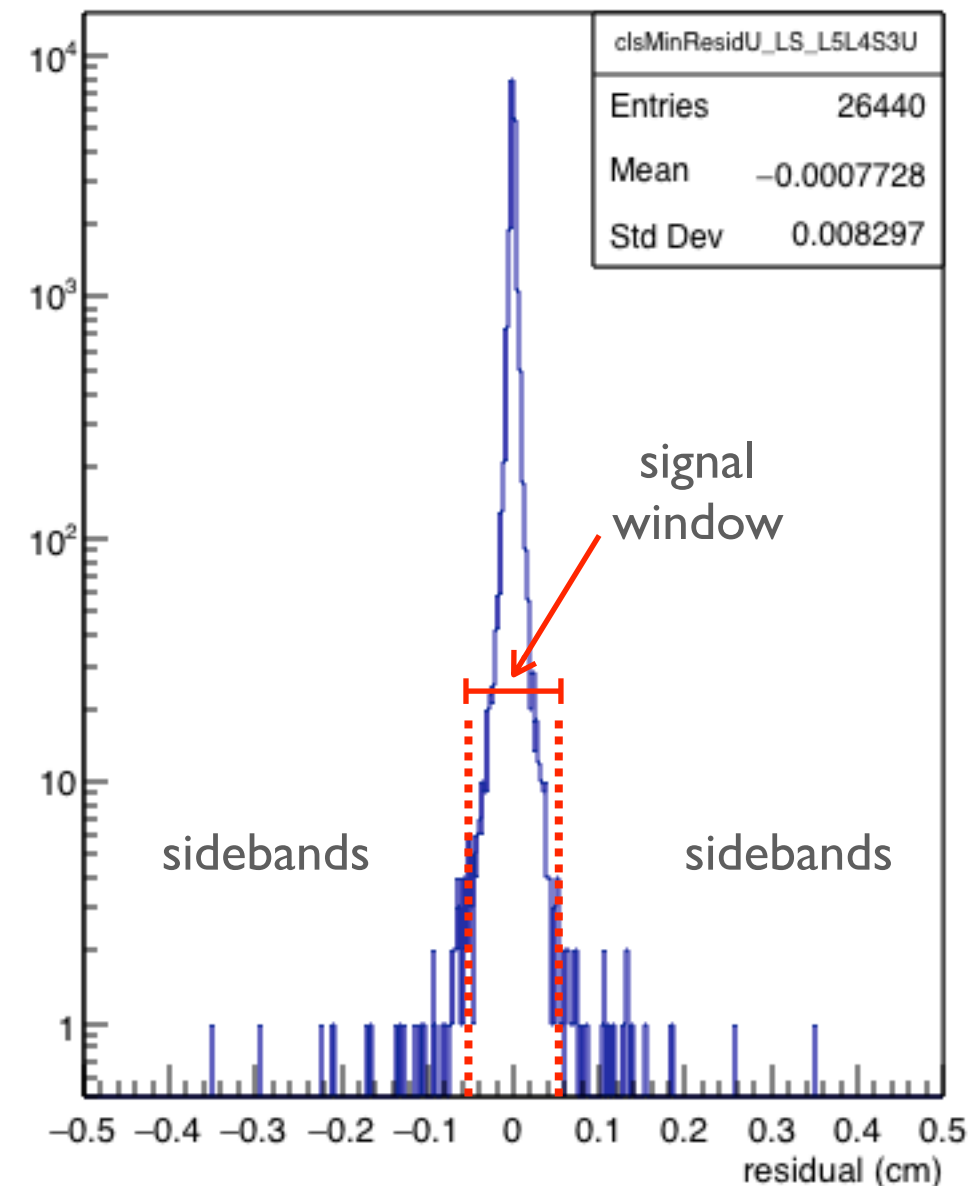
Final SVD Sensor Efficiency with Cosmics

- ➔ Sensor efficiency estimated using cosmic tracks in $\sim 10\text{M}$ events
- ➔ Tracking reconstruction *excluding* the sensors belonging to the layer under study, and applying quality cuts on clusters used in the pattern recognition and on the track
 - fiducial region for the extrapolation of the track to the sensor plane
- ➔ efficiency defined as the ratio between the background-subtracted clusters in the signal window (1mm wide) and the number of tracks extrapolated to the sensor plane
 - background clusters in the signal window estimated rescaling the number of clusters counted in the sidebands

V Cluster Residuals (layer 3, ladder 3, sensor 2, sideV/N)

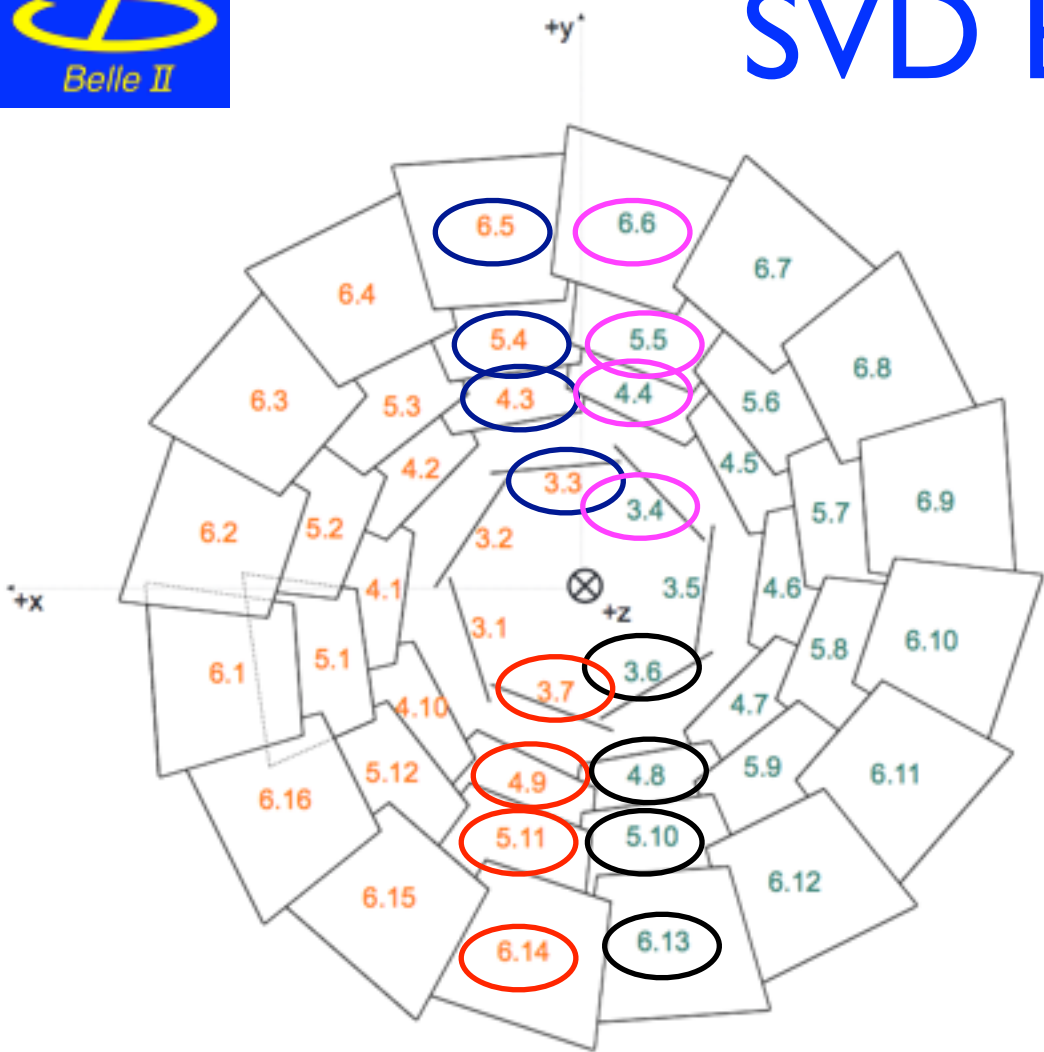


U Cluster Residuals (layer 5, ladder 4, sensor 3, sideU/P)



- ➔ Cluster residuals distribution width *does not provide* a measurement of the cluster position resolution: the intercept extrapolation error contributes to the residuals but can't be determined without B-field

SVD Efficiency, u/P side

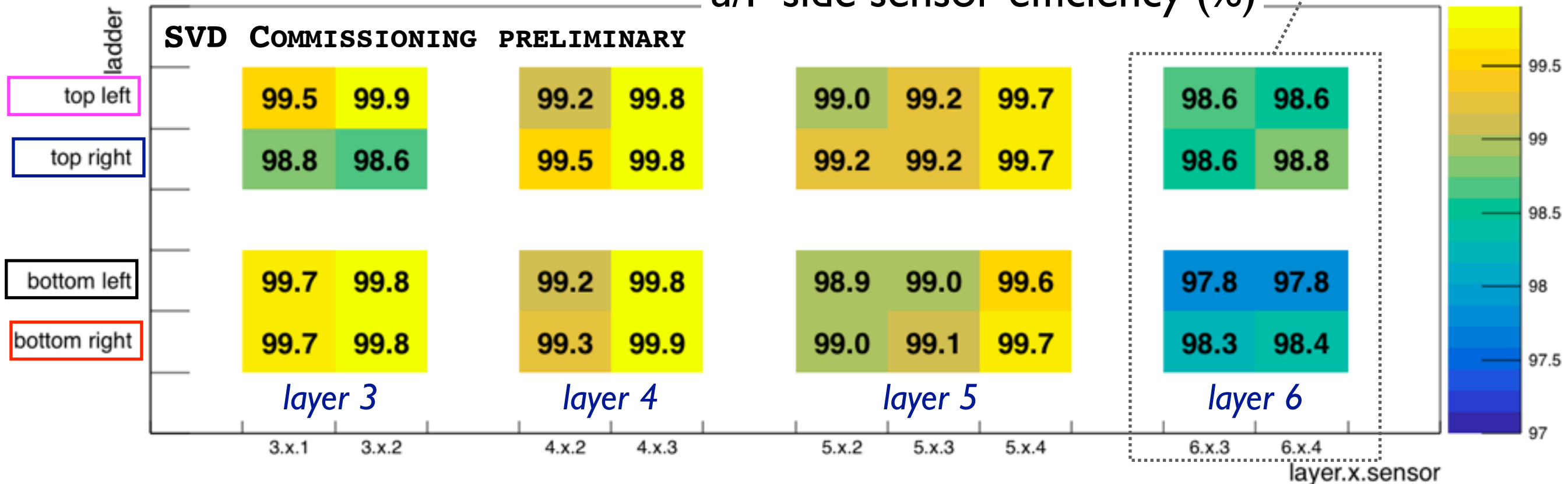


- efficiencies around/above 99% for sensors of the three innermost layers
- slightly lower efficiencies on layer 6, but still around 98%, above 97.4%

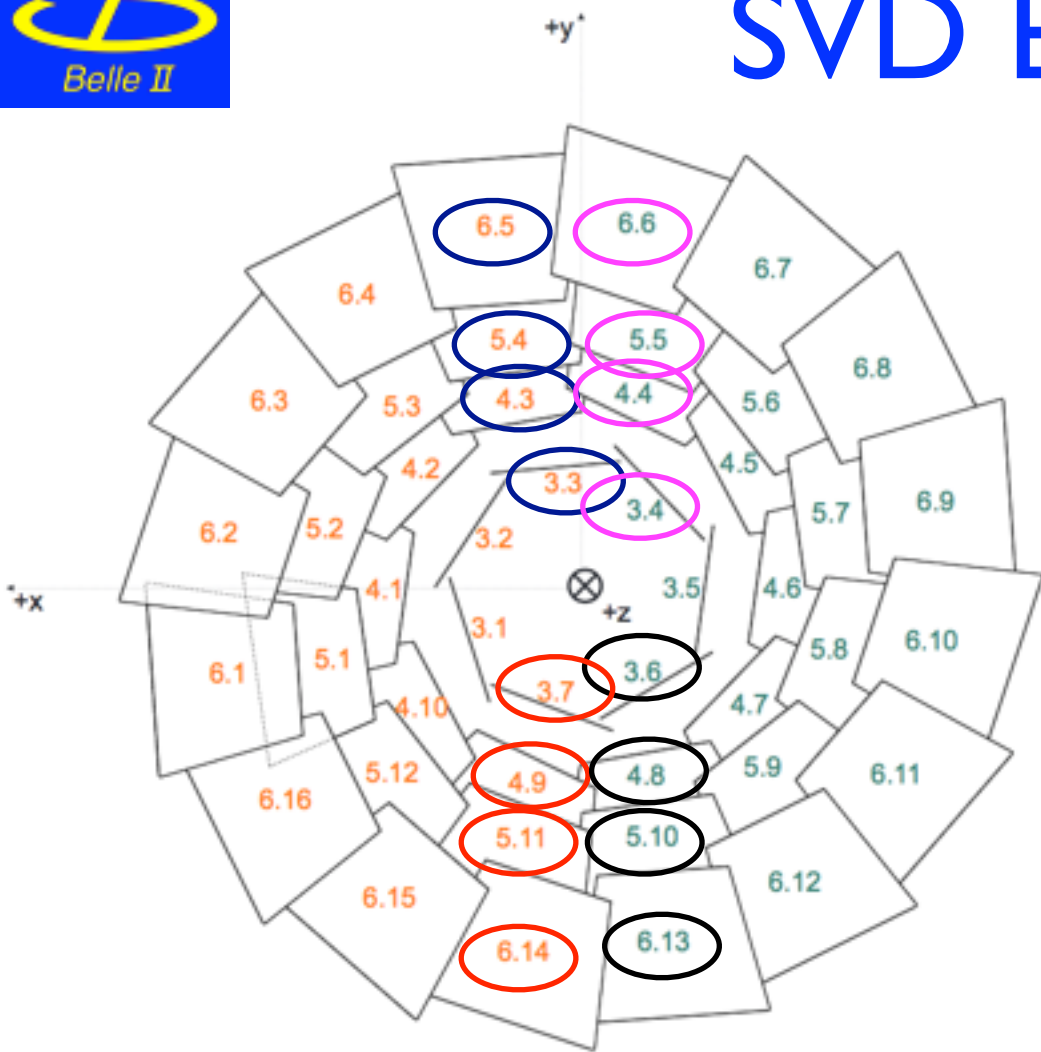
- all sensors are expected to have efficiencies compatible with the one estimated estimated with horizontal sensors
- statistical-only error < 0.1 %

lower since no tracking device placed outside L6

u/P side sensor efficiency (%)



SVD Efficiency, v/N side

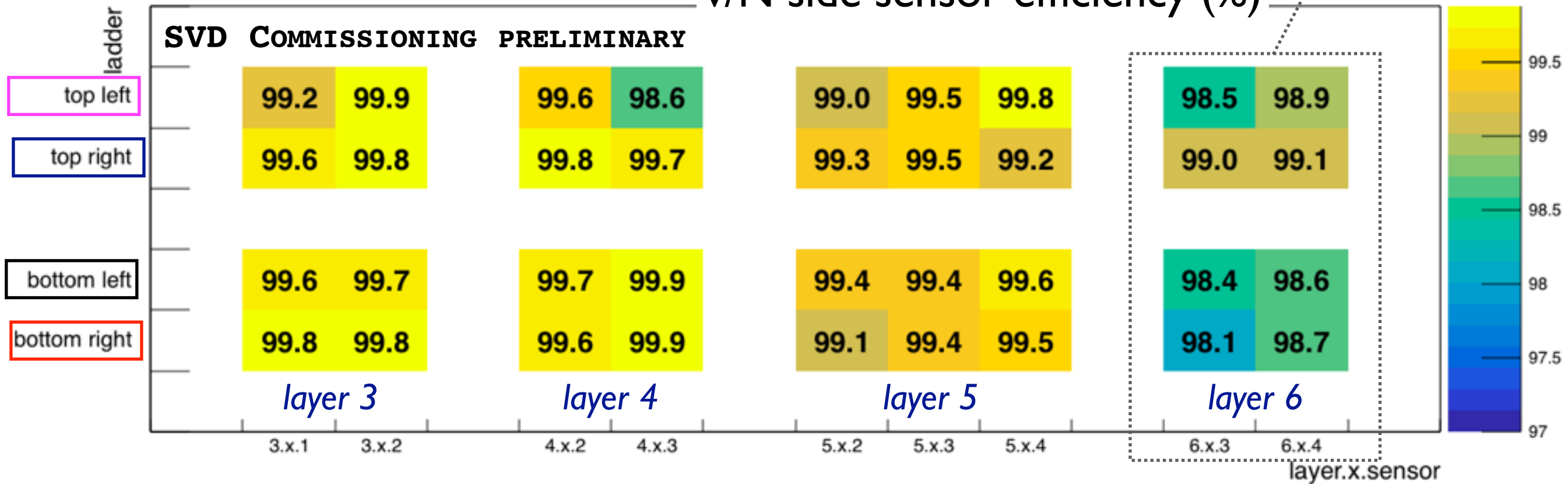


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v/N side sensor efficiency (%)



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SVD Final Destination

☑ The *Belle II* vertex detector has been successfully installed and integrated in the *Belle II* DAQ

➔ Since mid January SVD is included in *Belle II* global runs:

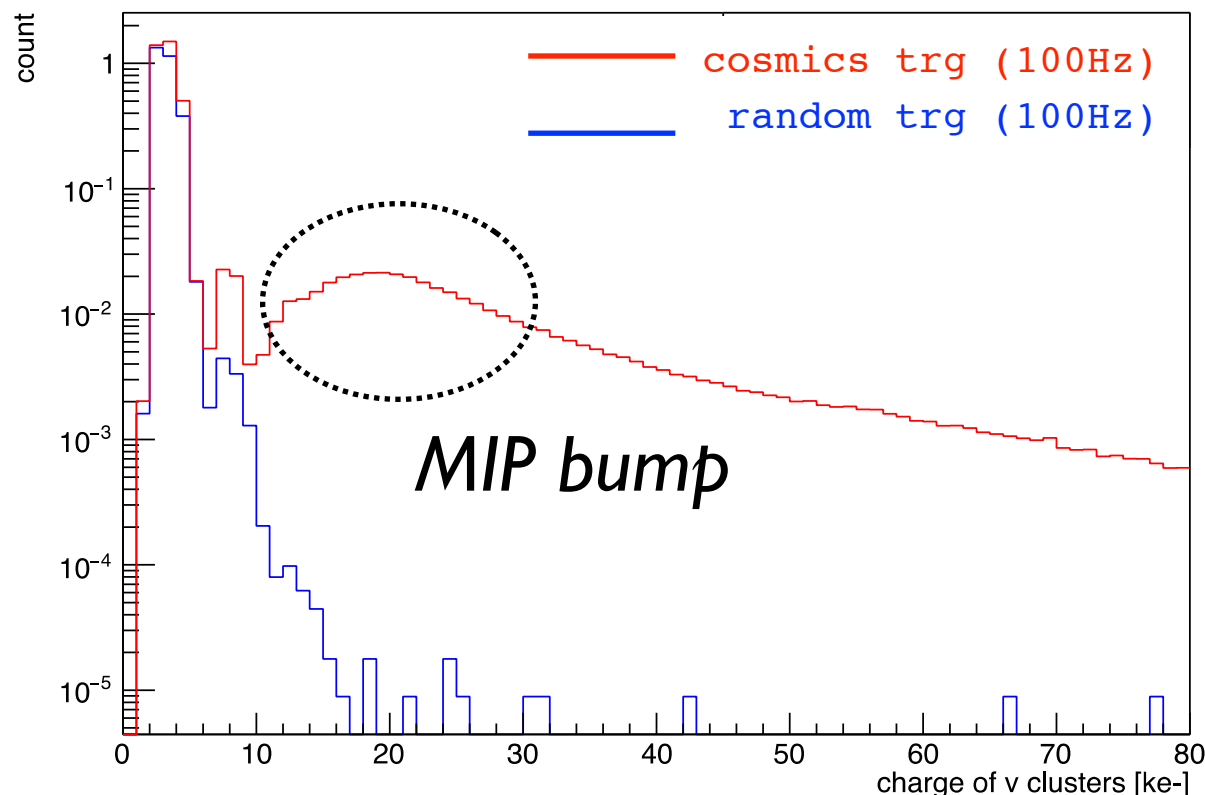
- random triggers with variable trigger rate, 1 - 30 kHz
- cosmics triggers, ~ 150 Hz (actually 5 Hz for tracks in SVD acceptance)
- cosmic + random triggers, variable trigger rate, 2 - 20 kHz

➔ Successful operations up to now:

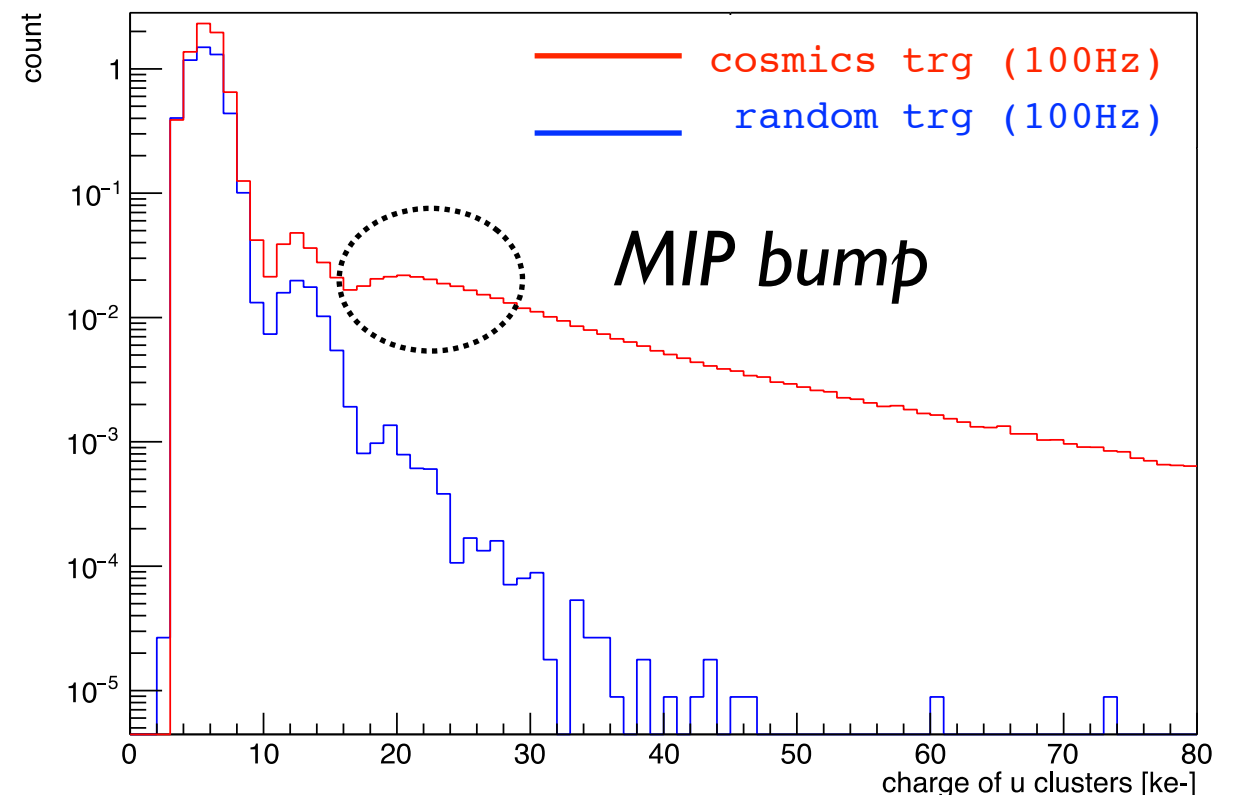
more details on SVD operations in Poster 66-A:
"Run and Slow Control of the BelleII Silicon Vertex Detector"
 by C. Irmeler

- all sensors are working, with cluster energy and SNR expected from MIPs

all-clusters charge for v/N side



all-clusters charge for u/P side



Track-related Cluster Energy

most probable cluster energy as expected from MIPs, around 80 keV

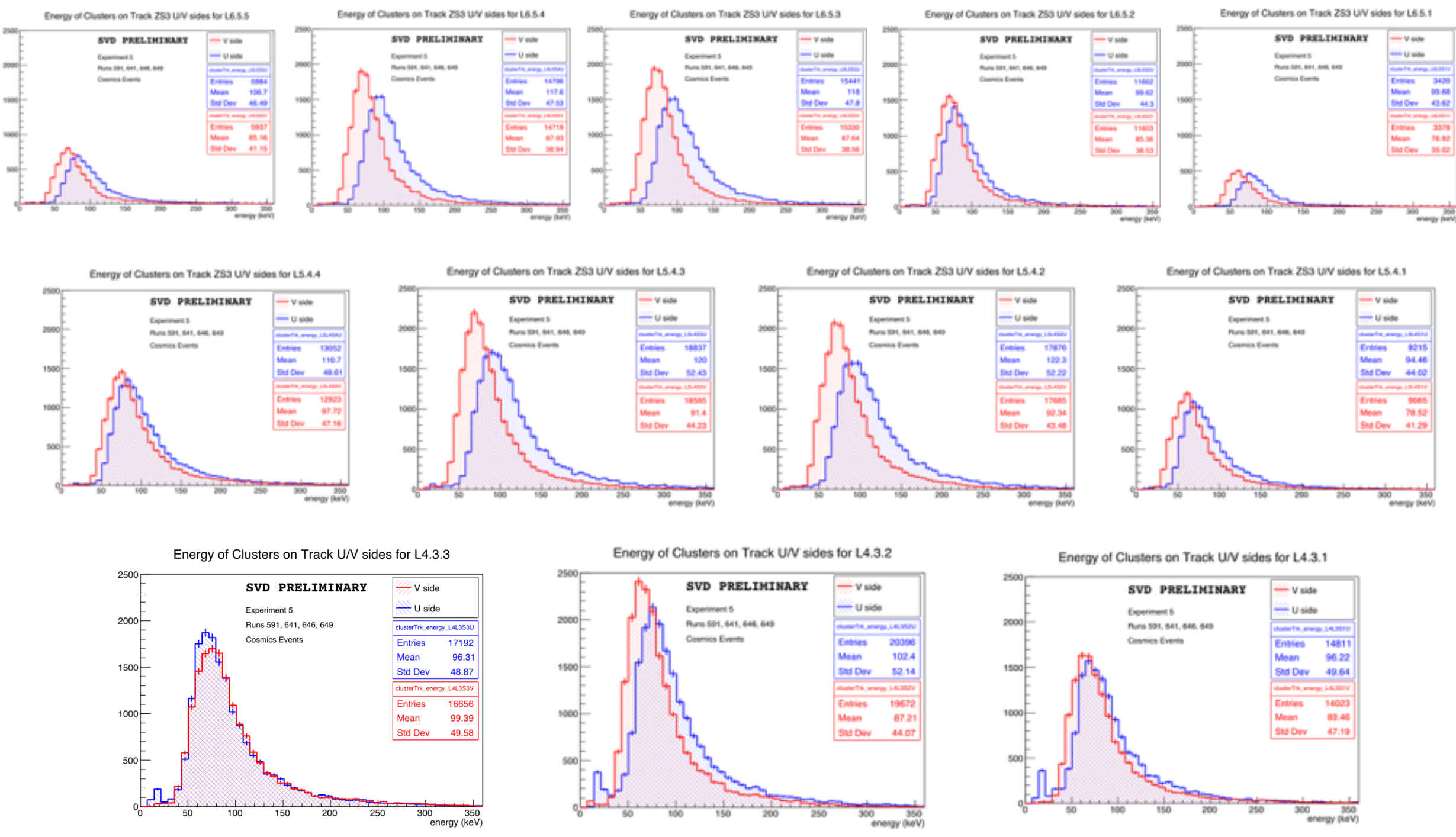
CDC

layer 6

layer 5

layer 4

IP

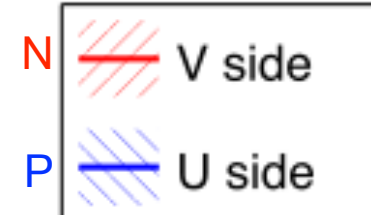


backward

forward

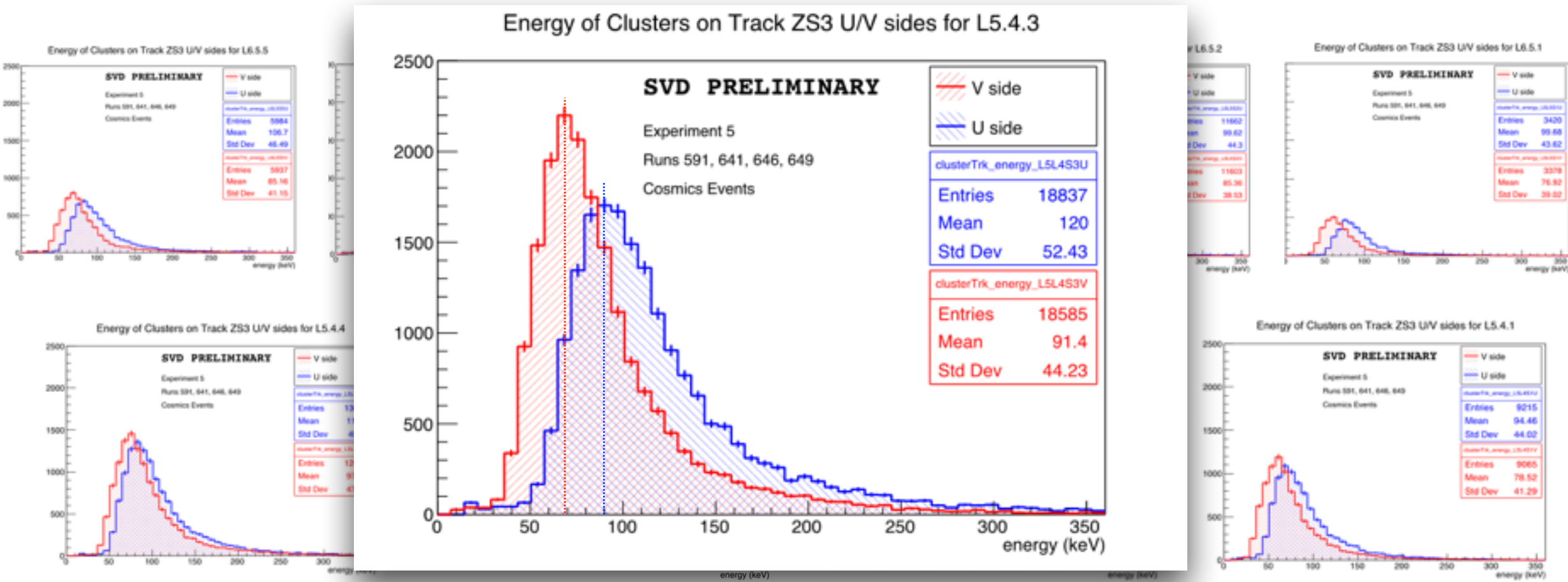
note: layer 3 in slide 23

Track-related Cluster Energy



most probable cluster energy as expected from MIPs, around 80 keV

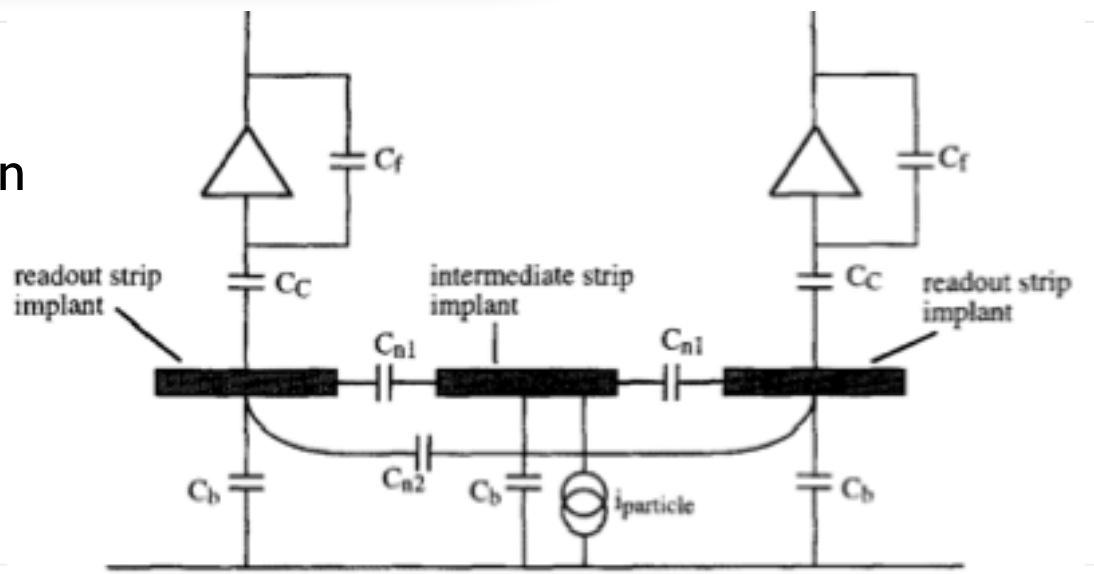
CDC
layer 6
layer 5
layer 4
IP
backward
forward



- ➔ Cluster energy similar for u/P and v/N sides
- ➔ 20% charge loss on N side due to coupling between floating and readout strip and large capacitance to the back side:

- fraction of signal from floating strip to readout:

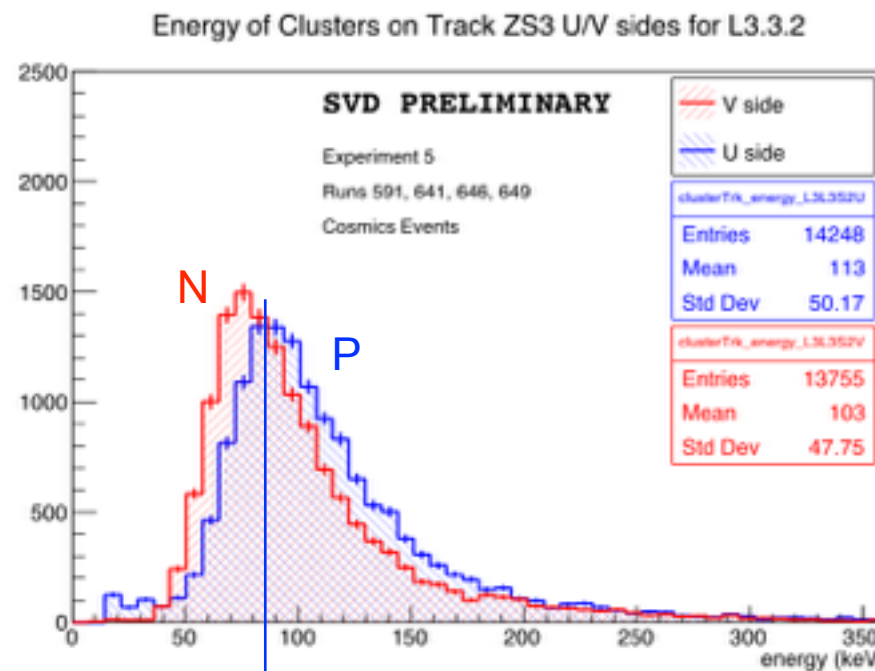
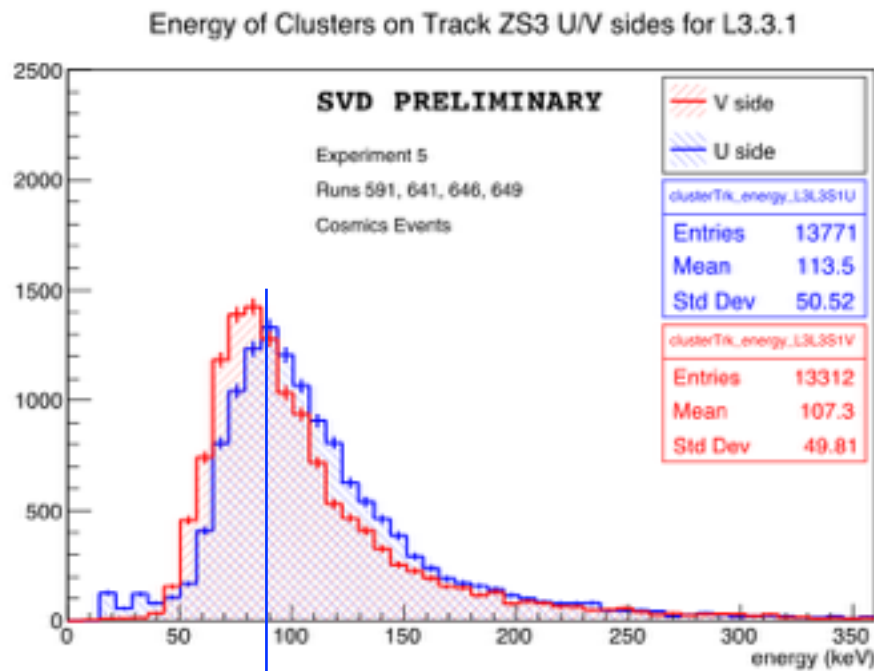
$$\frac{2C_i}{2C_i + C_b} \simeq 0.75(v/N), 0.9(u/P)$$



Cluster Energy, Zero Suppression Effect

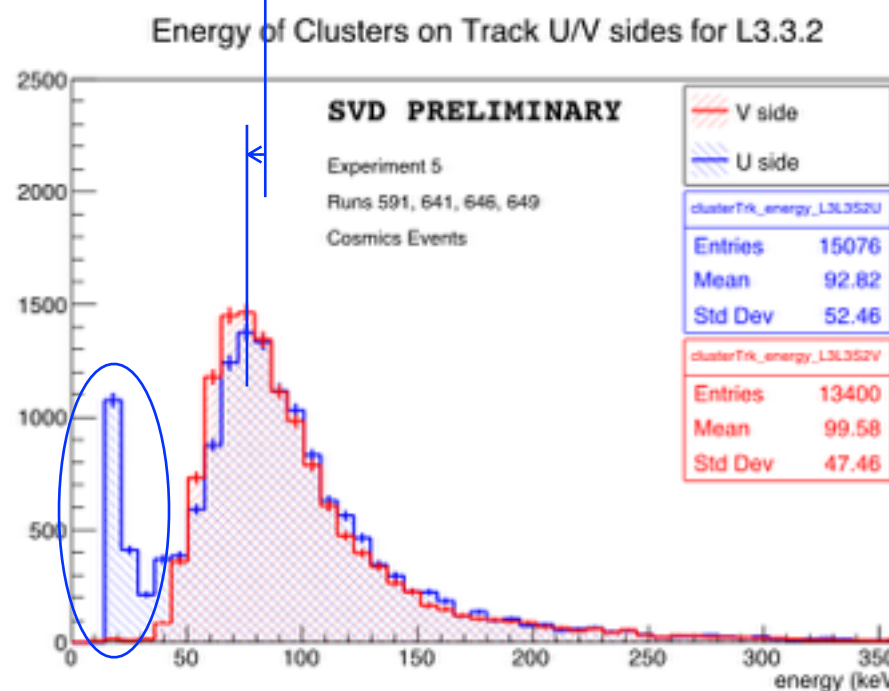
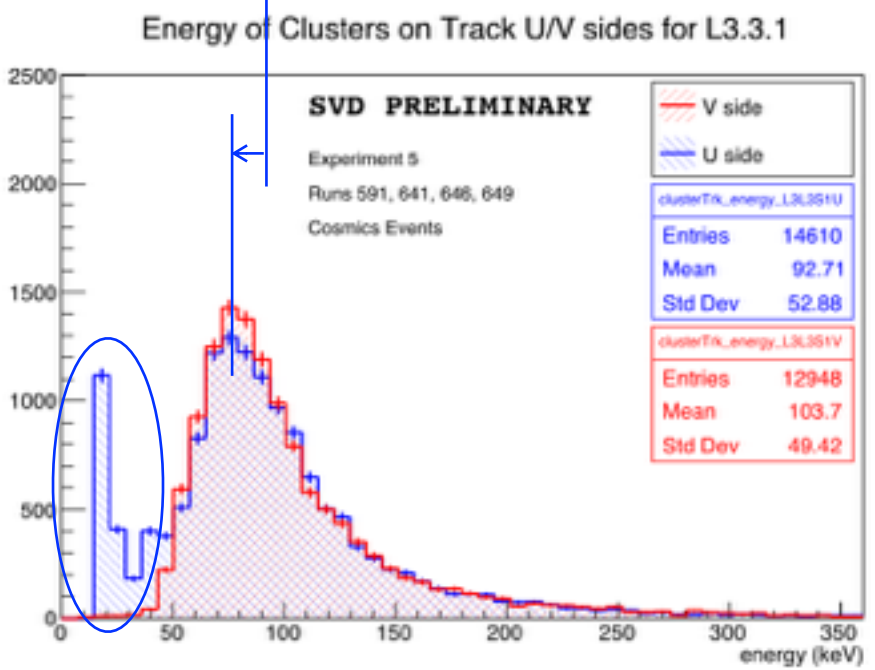
nominal online zero suppression, SNR cut = 3:

correct estimation of the cluster energy



online zero suppression:
SNR cut
from 3 to 5

higher online zero suppression, SNR cut = 5:

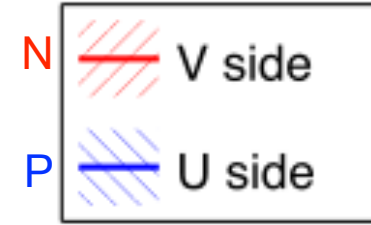


underestimation of the cluster energy of the u/P side:

- MPV cluster energy shifted to lower energy
 - loose strip(s) at the edge of the cluster
- appearance peak at low energy
 - cluster split effect

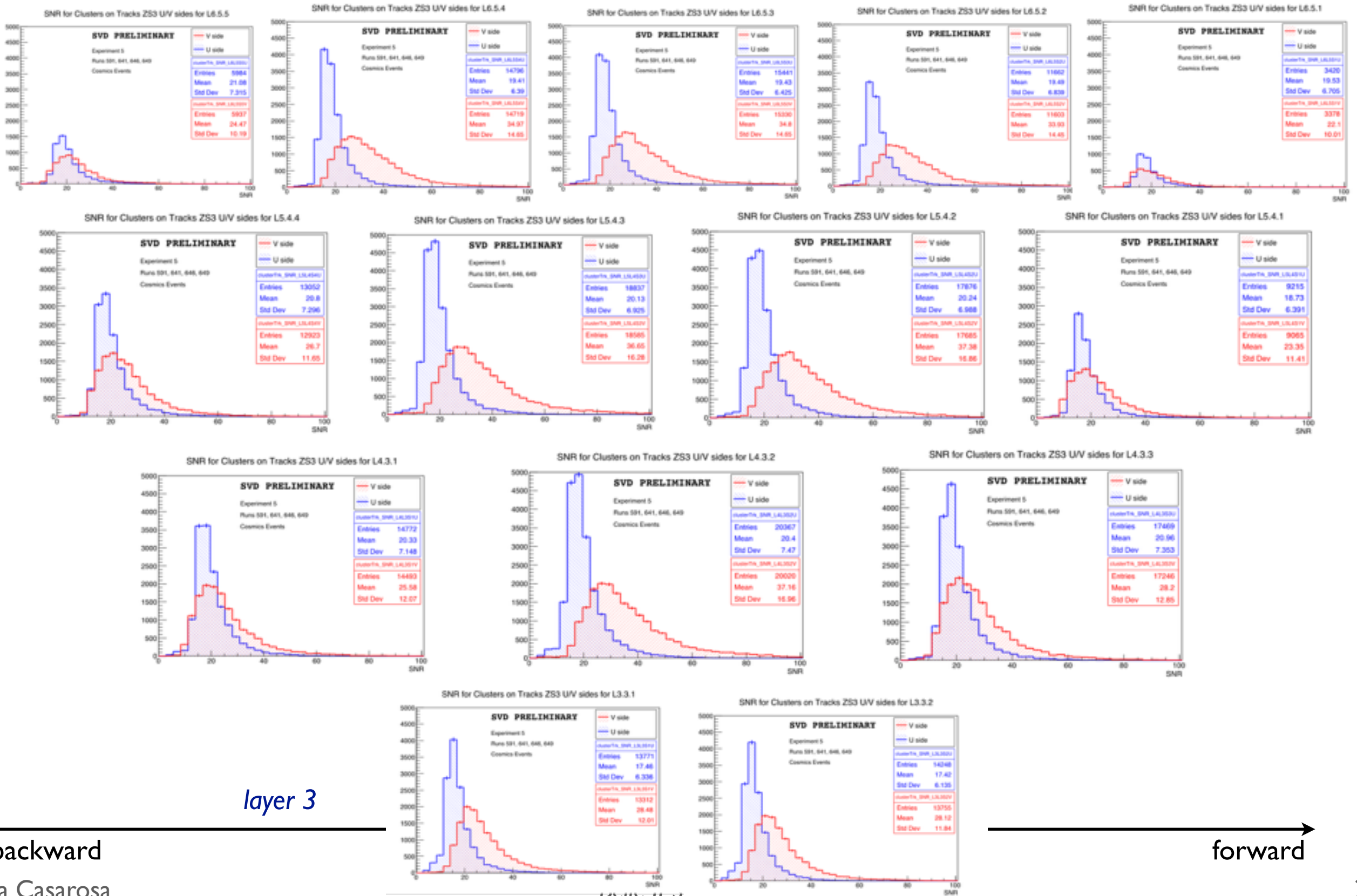
note: effect observed in all players
note: higher SNR minimizes the effect
on v/N side

Track-related Cluster SNR



good SNR for all sensors, as expected

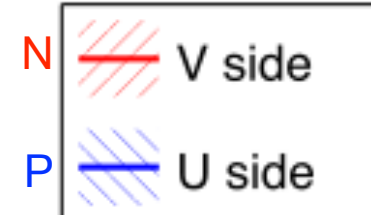
CDC
layer 6
layer 5
layer 4
IP



backward

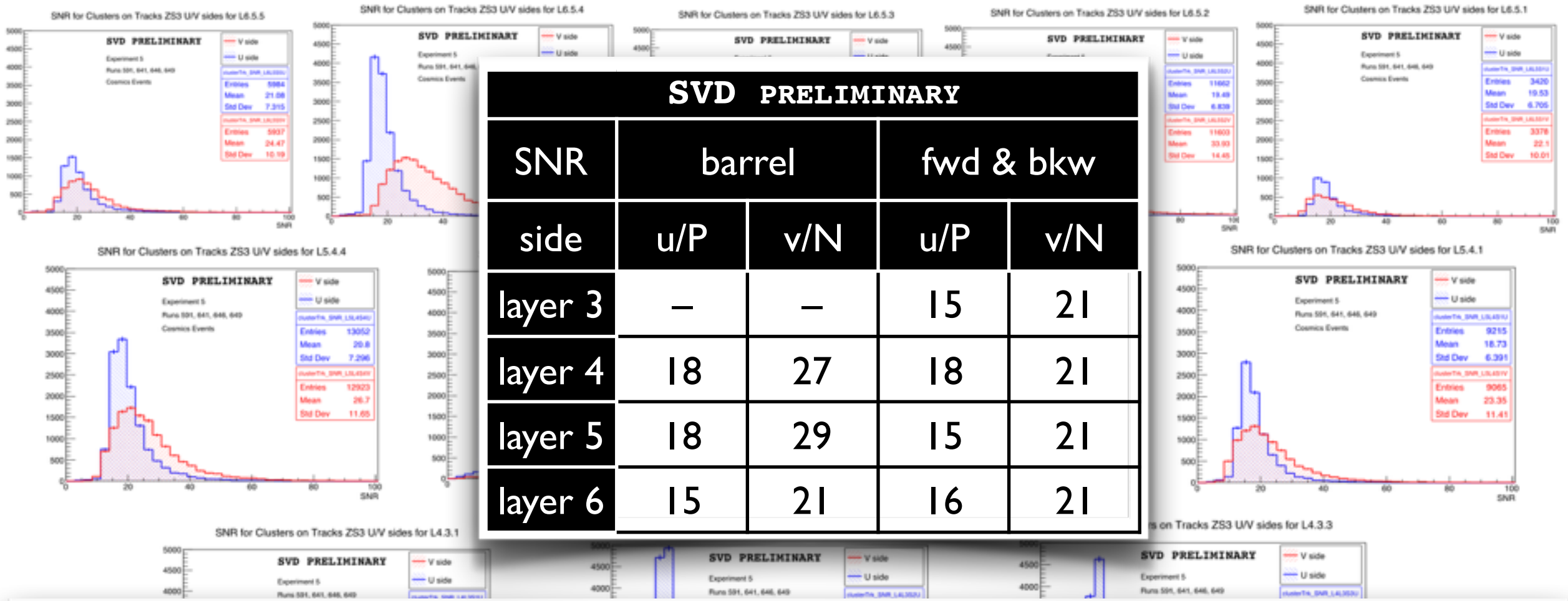
forward

Track-related Cluster SNR



good SNR for all sensors, as expected

CDC
↑
layer 6
layer 5
layer 4



SVD PRELIMINARY				
SNR	barrel		fwd & bkw	
	side	u/P	v/N	v/N
layer 3	—	—	15	21
layer 4	18	27	18	21
layer 5	18	29	15	21
layer 6	15	21	16	21

$$SNR_{cls} = \frac{\sum_{strips} S_i}{\sqrt{\sum_{strips} N_i^2}}$$

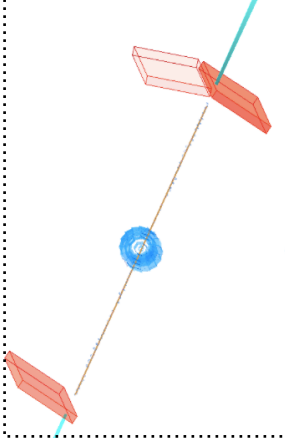
- SNR depends on collected charge, strip noise and cluster size
 - Noise u/P side (~900 e⁻) > Noise v/N side (~600 e⁻)
 - Signal u/P side > Signal v/N side
 - cluster size effect to be investigated
- The noise difference between the two sides is dominant with respect to cluster energy difference → higher SNR on v/N side

IP

backward

forward

Conclusions



The Silicon Vertex Detector has been successfully installed in Belle II

- SVD is included in global cosmics run, smooth operations so far
- all sensors are alive, detecting MIPs
- cluster energy and SNR distributions look as expected for MIPs

Phase2 data taking allowed to test a small-scale SVD on collisions data

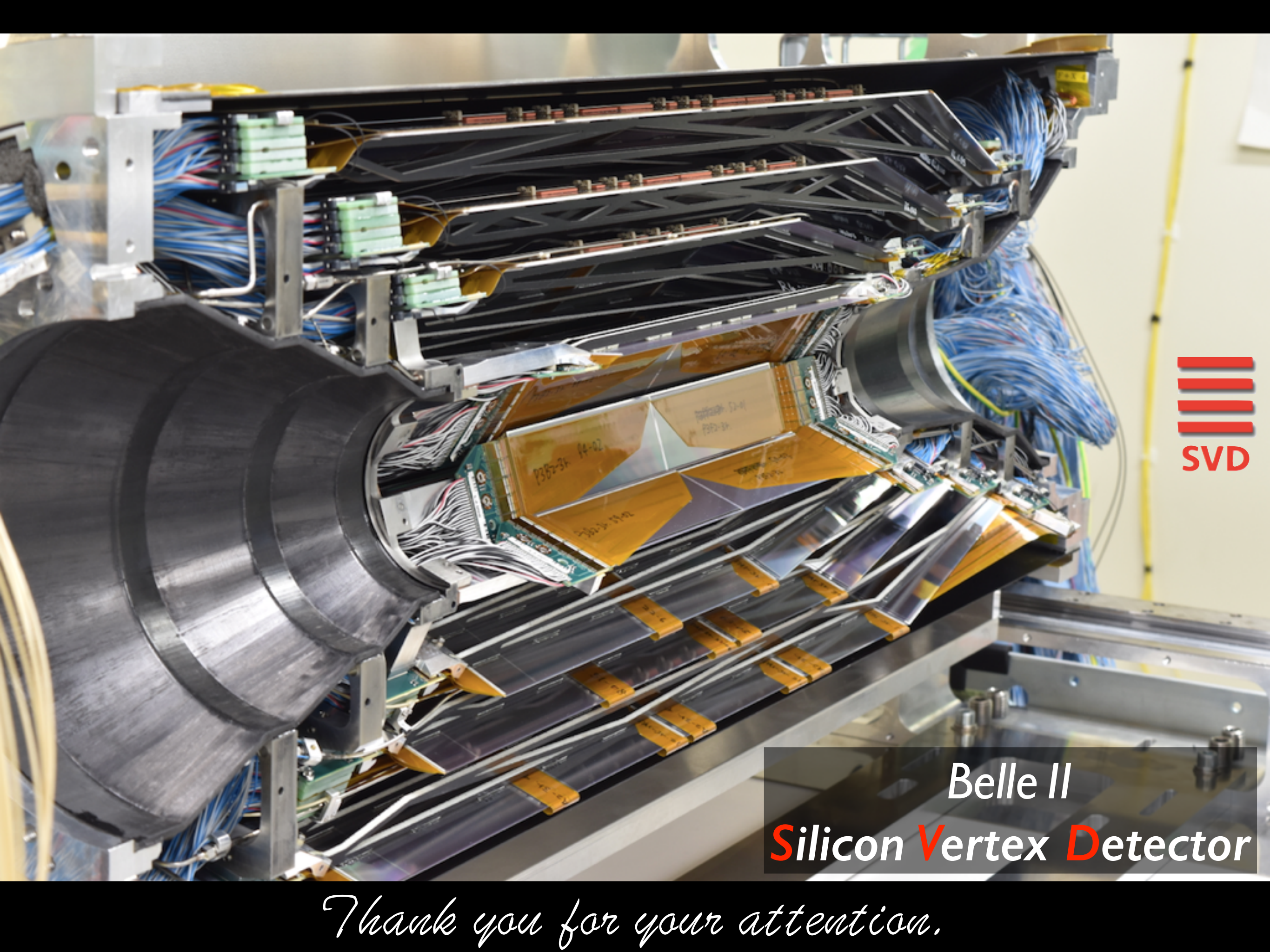
- excellent time resolution
- excellent feedbacks from tracking

Promising indications from the SVD standalone Commissioning, to be checked in the next weeks

- excellent sensor efficiency
- excellent detector stability

Looking forward to first collisions expected end of March

2019 01 27
cosmic track candidate
Exp 5
Run 690
Evt 14110



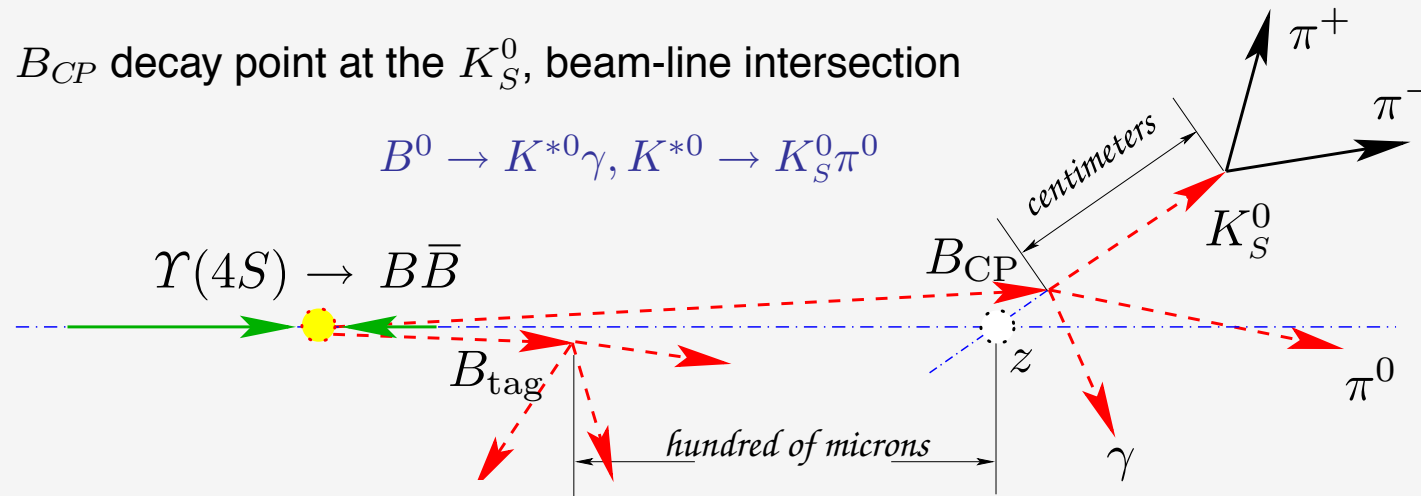
≡
≡
≡
SVD

Belle II
Silicon Vertex Detector

Thank you for your attention.

Vertexing at a B-Factory Experiment

- ➔ The Vertex Detector (VXD) provides the precise measurement of the primary and secondary vertices of short-lived particles

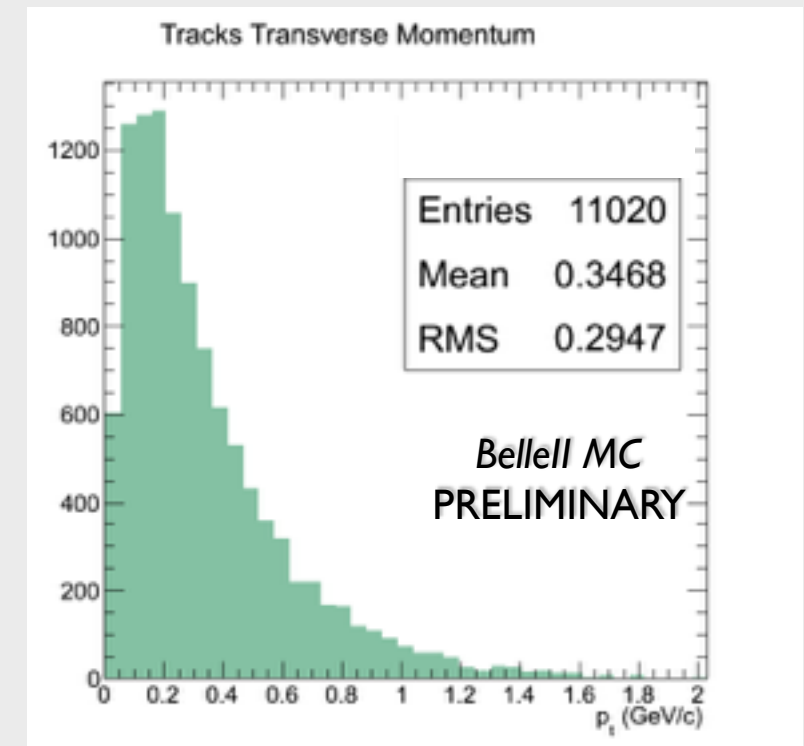


courtesy by E. Paoloni

- ➔ The most important factors affecting the *precision* of the vertex position determination are:
 - the distance of the first measured hit
 - the effect of multiple scattering
- ➔ Other important factors taken into account in the design are:
 - single hit resolution
 - impact of the machine background in terms of occupancy and radiation damage

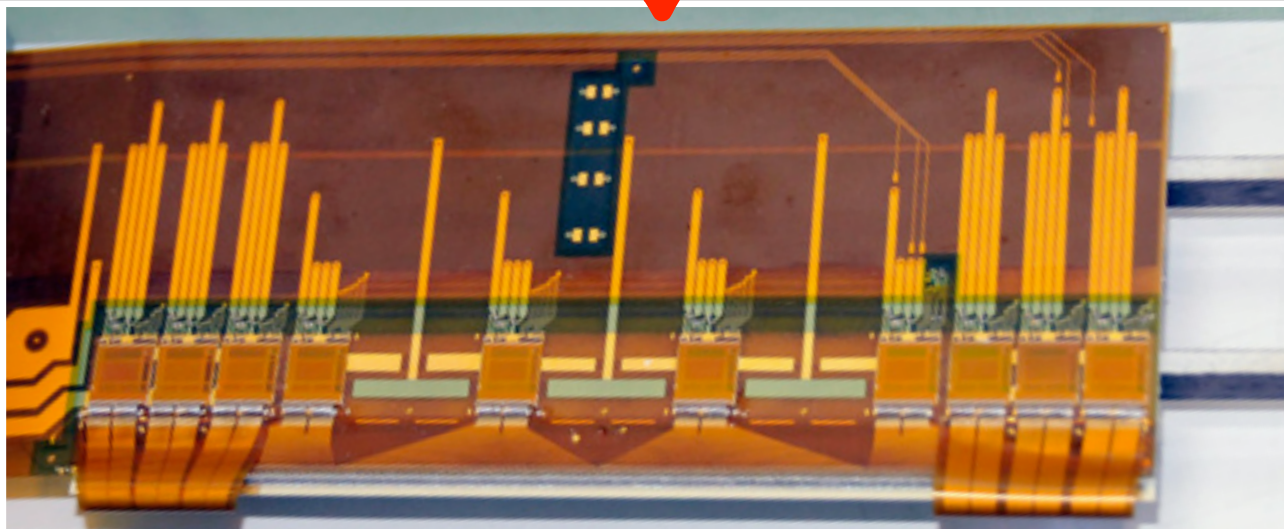
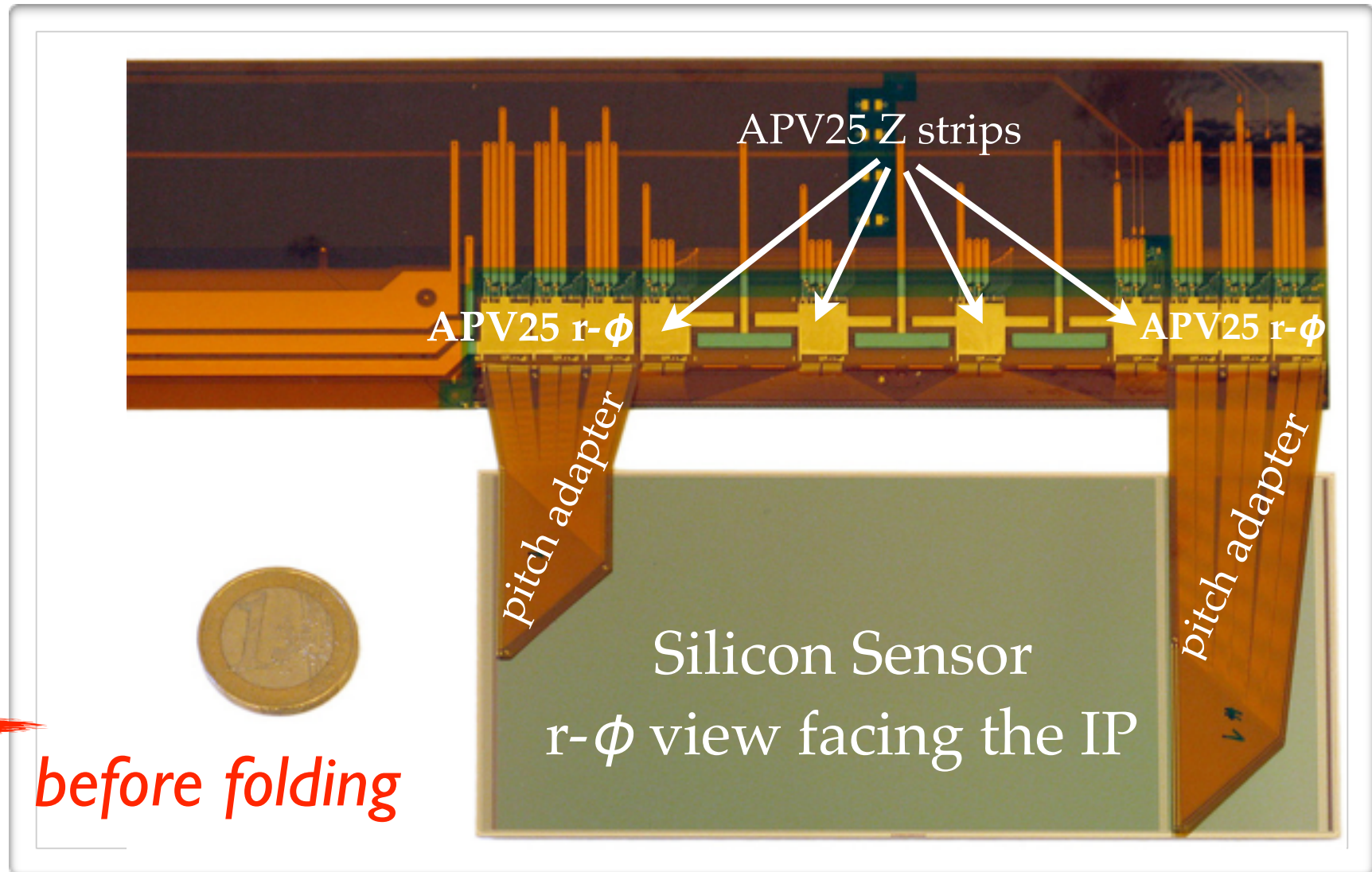
Typical $\Upsilon(4S)$ Event

- ➔ $\Upsilon(4S)$ center of mass is boosted
 - 7 GeV e^- on 4 GeV $e^+ \rightarrow \beta\gamma = 0.28$
 - reduced boost w.r.t. Belle
- ➔ average multiplicities
 - 11 charged tracks
 - 5 neutral pions
 - 1 neutral kaon
- ➔ soft charged tracks momentum spectrum



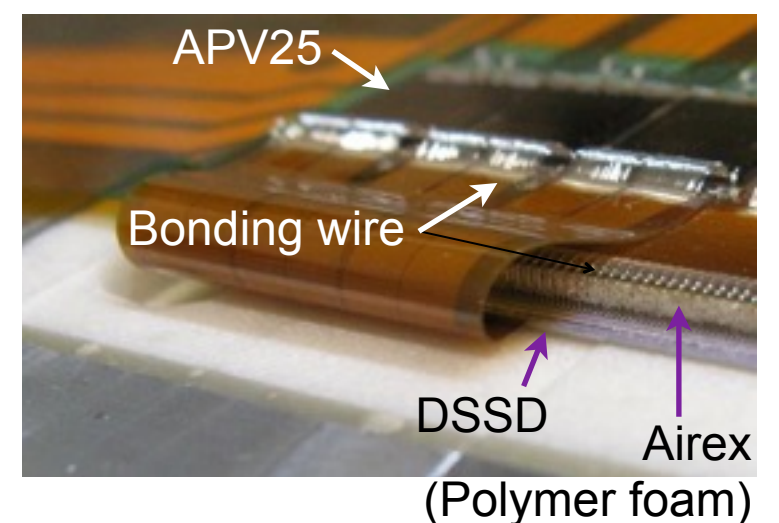
The Origami Concept

- ➔ SVD will operate at a high-luminosity machine ($8 \times 10^{35} \text{cm}^{-2} \text{s}^{-1}$)
- ➔ need short strips & short pitch adapters
 - reduce the occupancy
 - reduce the noise (lower capacitance at the charge preamplifier input)
- ➔ readout chips inside the tracking volume
- ➔ the “chip-on-sensor” Origami concept allows to minimise the analog path length



after folding

!! hidden micro bonding below the pitch adapter !!



Beam Background from Phase2

☑ It's safe to install the final SVD detector for early Phase3 data taking

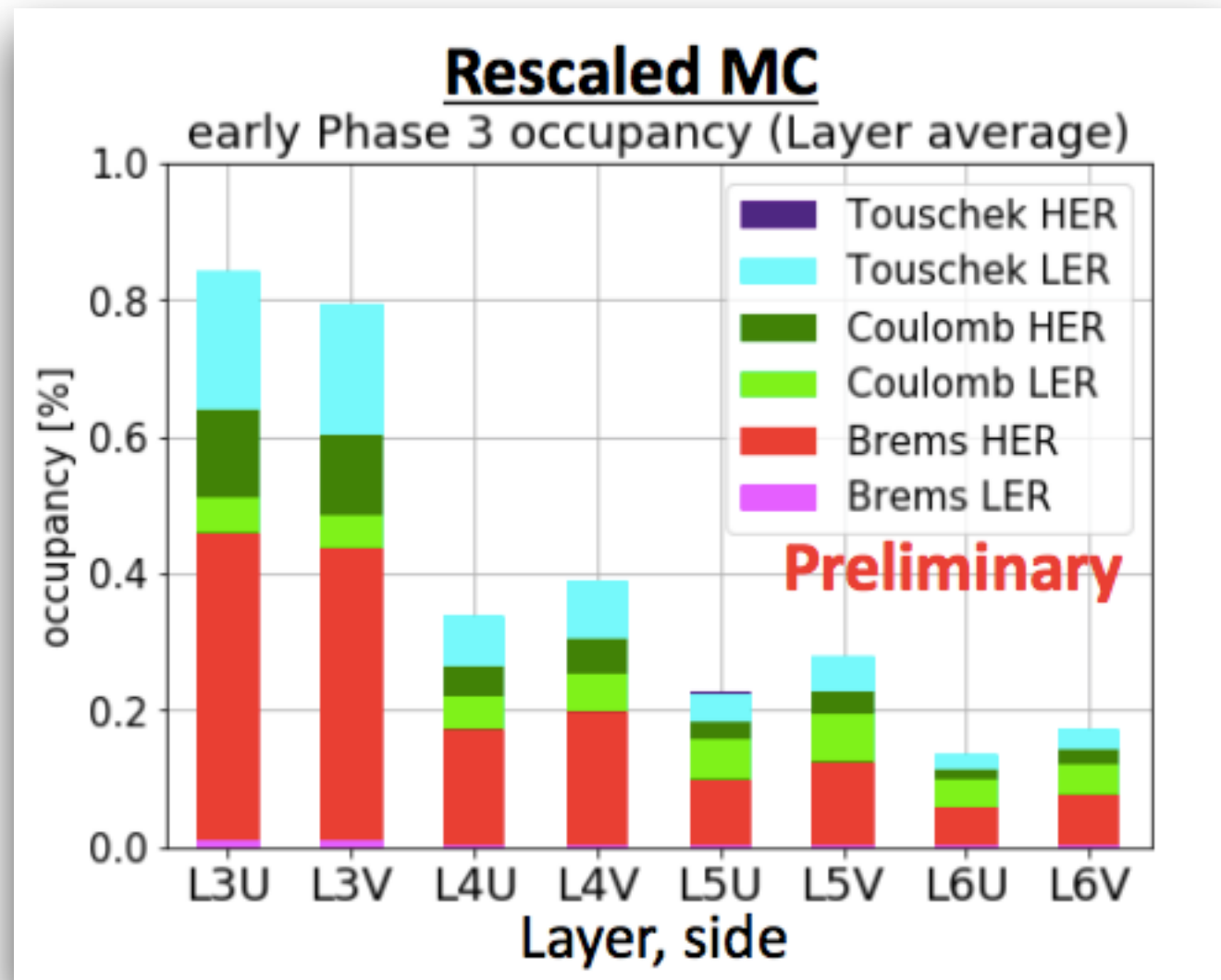
➔ Use beam background estimation from Phase2 to get expected background on early Phase3:

- decomposition of beam-induced backgrounds

$$O(I, P, \sigma_Y, n_b) = \underbrace{B}_{\text{beam-gas rate}} \cdot PI + \underbrace{T}_{\text{Touschek rate}} \cdot \frac{I^2}{\sigma_y n_b}$$

- occupancy measured for different configurations of the beam parameters allows to extract B and T
- data MC comparison to extract scaling factors for beam-gas and Touschek rates:

$$Expected_{Phase3} = MC_{Phase3} \cdot \frac{Data_{Phase2}}{MC_{Phase2}}$$



➔ Background levels in earlyPhase3 will be acceptable for the final SVD detector

- occupancy limit from tracking ~3%
- luminosity background will be negligible in early Phase3

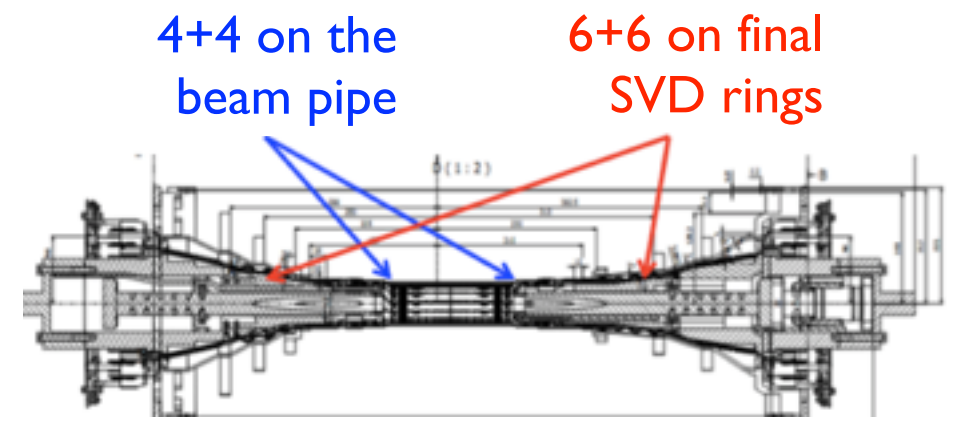
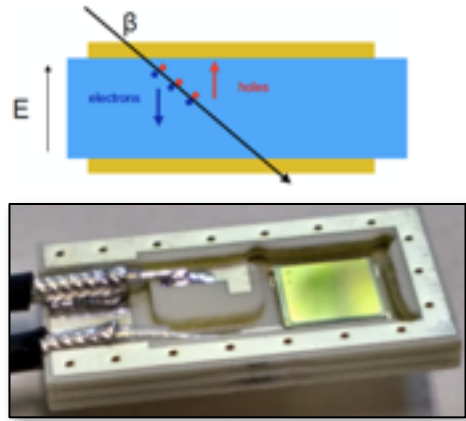
luminosity bkg = 1% at design luminosity & it scales with luminosity

SVD Subsystems Commissioned in Phase2

Radiation Monitor: essential to protect VXD from a large instantaneous or time-integrated dose by aborting the beams.

Diamond chambers:

- high radiation tolerance
- proper response to both rapid and slow increases of the radiation level
- reduced dependence of the leakage current on the total dose.

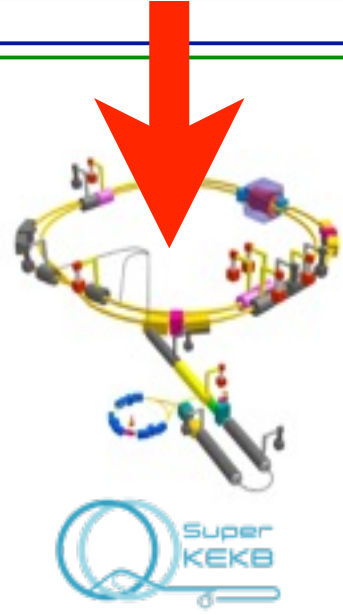


Phase2 highest dose | 1.6 krad

Beam Abort System:

beam abort request to protect SVD and final focus magnets:

- fast abort: 1 rad/ms, \rightarrow 86 in Phase2 (10 μ s reaction time)
- slow abort: 100 mrad/s \rightarrow 12 in Phase2
- thresholds adjustable



Dump the last second of data before the abort:

- Dump the last 100k samples in a R/O buffer (100kHz for 1s) to a memory.
- content of the R/O buffer correctly frozen and dump
- analysis of these data showed the abort was correctly issued

Interlock Systems: hardware and software interlocks to completely turn off the detector in case of problems

Environmental Monitors

- FOS & NTC temperatures
- humidity

- Minor but real instances happened during Phase2 operations.
- For each instance, the interlock system properly halted the SVD power supplies.

